# 1. General description

The ISP1504 is a Universal Serial Bus (USB) On-The-Go (OTG) transceiver that is fully compliant with *Universal Serial Bus Specification Rev. 2.0*, *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2* and *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

The ISP1504 can transmit and receive USB data at high-speed (480 Mbit/s), full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s), and provides a pin-optimized, physical layer front-end attachment to USB host, peripheral and OTG devices.

It is ideal for use in portable electronic devices, such as mobile phones, digital still cameras, digital video cameras, Personal Digital Assistants (PDAs) and digital audio players. It allows USB Application-Specific Integrated Circuits (ASICs), Programmable Logic Devices (PLDs) and any system chip set to interface with the physical layer of the USB through a 12-pin interface.

The ISP1504 can interface to the link with digital I/O voltages in the range of 1.65 V to 3.6 V.

The ISP1504 is available in HVQFN32 package.

#### 2. Features

- Fully complies with:
  - Universal Serial Bus Specification Rev. 2.0
  - ◆ On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2
  - ◆ UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1
- Interfaces to host, peripheral and OTG device cores; optimized for portable devices or system ASICs with built-in USB OTG device core
- Complete Hi-Speed USB physical front-end solution that supports high-speed (480 Mbit/s), full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s)
  - Integrated 45  $\Omega$  ± 10 % high-speed termination resistors, 1.5 k $\Omega$  ± 5 % full-speed device pull-up resistor, and 15 k $\Omega$  ± 5 % host termination resistors
  - Integrated parallel-to-serial and serial-to-parallel converters to transmit and receive
  - ◆ USB clock and data recovery to receive USB data at ±500 ppm
  - ♦ Insertion of stuff bits during transmit and discarding of stuff bits during receive
  - Non-Return-to-Zero Inverted (NRZI) encoding and decoding
  - Supports bus reset, suspend, resume and high-speed detection handshake (chirp)
- Complete USB OTG physical front-end that supports Host Negotiation Protocol (HNP) and Session Request Protocol (SRP)



- Integrated 5 V charge pump; also supports external charge pump or 5 V V<sub>BUS</sub> switch
- Complete control over bus resistors
- Data line and V<sub>BUS</sub> pulsing session request methods
- Integrated V<sub>BUS</sub> voltage comparators
- Integrated cable (ID) detector
- Highly optimized ULPI-compliant interface
  - ◆ 60 MHz, 8-bit interface between the core and the transceiver
  - ◆ Supports both 60 MHz input clock and 60 MHz output clock configurations
  - Integrated Phase-Locked Loop (PLL) with auto-configuring support for 60 MHz input clock, or one crystal or clock frequency: 19.2 MHz (ISP1504ABS) and 26 MHz (ISP1504CBS)
  - Fully programmable ULPI-compliant register set
  - ◆ Internal Power-On Reset (POR) circuit
- Flexible system integration and very low current consumption, optimized for portable devices
  - Power-supply input range is 3.0 V to 3.6 V
  - Internal voltage regulator supplies 3.3 V and 1.8 V
  - Charge pump regulator outputs 4.75 V to 5.25 V at a current of up to 50 mA, tunable using an external capacitor
  - Supports external V<sub>BUS</sub> charge pump or 5 V V<sub>BUS</sub> switch:
     External V<sub>BUS</sub> source is controlled using the PSW\_N pin; open-drain PSW\_N allows per-port or ganged power control
     Digital FAULT input to monitor the external V<sub>BUS</sub> supply status
  - Pin CHIP\_SELECT\_N 3-states the ULPI interface, allowing bus reuse for other applications
  - Supports wide range interfacing I/O voltage of 1.65 V to 3.6 V; separate I/O voltage pins minimize crosstalk
  - Typical operating current of 10 mA to 48 mA, depending on the USB speed and bus utilization; not including the charge pump
  - Typical suspend current of 35 μA
- Full industrial grade operating temperature range from –40 °C to +85 °C
- 4 kV ElectroStatic Discharge (ESD) protection at pins DP, DM, ID, V<sub>BUS</sub> and GND
- Available in a small HVQFN32 (5 mm × 5 mm) Restriction of Hazardous Substances (RoHS) compliant, halogen-free and lead-free package

# 3. Applications

- Digital still camera
- Digital TV
- Digital Video Disc (DVD) recorder
- External storage device, for example:
  - Zip drive
  - Magneto-Optical (MO) drive
  - Optical drive: CD-ROM, CD-RW, DVD
- Mobile phone

- MP3 player
- PDA
- Printer
- Scanner
- Set-Top Box (STB)
- Video camera

# 4. Ordering information

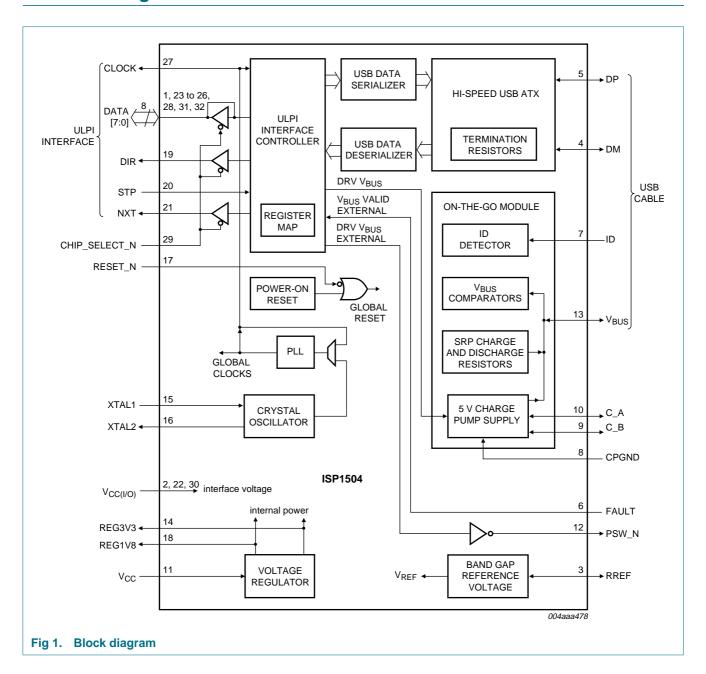
Table 1. Ordering information

| Part        |         |                            | Package |  |          |  |  |
|-------------|---------|----------------------------|---------|--|----------|--|--|
| Type number | Marking | Crystal or clock frequency | Name    | Description  | Version  |  |  |
| ISP1504ABS  | 504A[1] | 19.2 MHz                   | HVQFN32 | plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body $5\times5\times0.85$ mm       | SOT617-1 |  |  |
| ISP1504CBS  | 504C[1] | 26 MHz                     | HVQFN32 | plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 $\times$ 5 $\times$ 0.85 mm | SOT617-1 |  |  |

<sup>[1]</sup> The package marking is the first line of text on the IC package and can be used for IC identification.

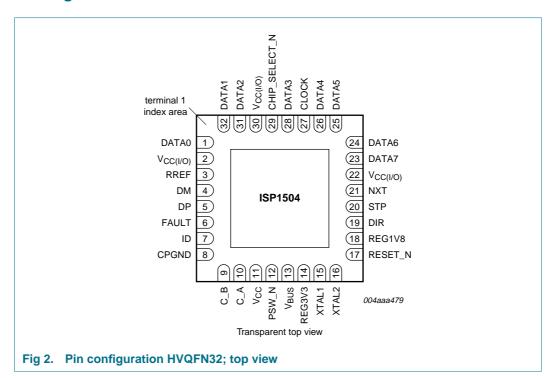
4 of 84

# 5. Block diagram



# 6. Pinning information

## 6.1 Pinning



## 6.2 Pin description

Table 2. Pin description

| Symbol[1][2]         | Pin | Type[3] | Description[4]   |
|----------------------|-----|---------|--|
| DATA0                | 1   | I/O     | pin 0 of the bidirectional ULPI data bus   |
|                      |     |         | slew-rate controlled output (1 ns); plain input; programmable pull down                  |
| V <sub>CC(I/O)</sub> | 2   | Р       | I/O supply rail  |
| RREF                 | 3   | AI/O    | resistor reference   |
| DM                   | 4   | AI/O    | data minus (D-) pin of the USB cable   |
| DP                   | 5   | AI/O    | data plus (D+) pin of the USB cable  |
| FAULT                | 6   | I       | input pin for the external V <sub>BUS</sub> digital overcurrent or fault detector signal |
|                      |     |         | plain input; 5 V tolerant  |
| ID                   | 7   | I       | identification (ID) pin of the mini-USB cable  |
|                      |     |         | plain input; TTL level   |
| CPGND                | 8   | Р       | charge pump ground   |
| C_B                  | 9   | AI/O    | flying capacitor pin connection for the charge pump                                      |
| C_A                  | 10  | AI/O    | flying capacitor pin connection for the charge pump                                      |
| V <sub>CC</sub>      | 11  | Р       | input supply voltage or battery source   |
| PSW_N                | 12  | OD      | active LOW external V <sub>BUS</sub> power switch or external charge pump enable         |
|                      |     |         | open-drain; 5 V tolerant   |

Table 2. Pin description ... continued

| Symbol <sup>[1][2]</sup>   | Pin | Type[3] | Description <sup>[4]</sup>   |
|----------------------------|-----|---------|--|
| $V_{BUS}$                  | 13  | AI/O    | V <sub>BUS</sub> pin of the USB cable<br>5 V tolerant  |
| REG3V3                     | 14  | Р       | 3.3 V regulator output   |
| XTAL1                      | 15  | Al      | crystal oscillator or clock input  |
| XTAL2                      | 16  | AO      | crystal oscillator output  |
| RESET_N                    | 17  | I       | active LOW, asynchronous reset input   |
|                            |     |         | plain input  |
| REG1V8                     | 18  | Р       | 1.8 V regulator output   |
| DIR                        | 19  | 0       | ULPI direction signal  |
|                            |     |         | slew-rate controlled output (1 ns)   |
| STP                        | 20  | I       | ULPI stop signal   |
|                            |     |         | plain input; programmable pull up  |
| NXT                        | 21  | 0       | ULPI next signal   |
|                            |     |         | slew-rate controlled output (1 ns)   |
| V <sub>CC(I/O)</sub>       | 22  | Р       | I/O supply rail  |
| DATA7                      | 23  | I/O     | pin 7 of the bidirectional ULPI data bus   |
|                            |     |         | slew-rate controlled output (1 ns); plain input; programmable pull down  |
| DATA6                      | 24  | I/O     | pin 6 of the bidirectional ULPI data bus   |
|                            |     |         | slew-rate controlled output (1 ns); plain input; programmable pull down  |
| DATA5                      | 25  | I/O     | pin 5 of the bidirectional ULPI data bus   |
|                            |     |         | slew-rate controlled output (1 ns); plain input; programmable pull down  |
| DATA4                      | 26  | I/O     | pin 4 of the bidirectional ULPI data bus   |
|                            |     |         | slew-rate controlled output (1 ns); plain input; programmable pull down  |
| CLOCK                      | 27  | I/O     | 60 MHz clock output when a crystal is attached; requires 60 MHz clock input when                                 |
|                            |     |         | the crystal is not attached  |
| DATAO                      | 20  | 1/0     | slew-rate controlled output (1 ns); plain input  |
| DATA3                      | 28  | I/O     | pin 3 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down |
| CHID SELECT                | 20  |         | active LOW chip select   |
| CHIP_SELECT_N              | 29  | ı       | plain input  |
|                            | 30  | Р       | I/O supply rail  |
| V <sub>CC(I/O)</sub> DATA2 |     | I/O     |  |
| DAIAZ                      | 31  | 1/0     | pin 2 of the bidirectional ULPI data bus slew-rate controlled output (1 ns); plain input; programmable pull down |
| DATA1                      | 32  | I/O     | pin 1 of the bidirectional ULPI data bus   |
| DAIAT                      | SZ  | 1/0     | slew-rate controlled output (1 ns); plain input; programmable pull down  |
| GND                        | die | Р       | ground supply; down bonded to the exposed die pad (heat sink); to be connected to                                |
|                            | pad | •       | the PCB ground   |
|                            |     |         |  |

<sup>[1]</sup> Symbol names ending with underscore N, for example, NAME\_N, indicate active LOW signals.

<sup>[2]</sup> For details on external components required on each pin, see bill of materials and application diagrams in Section 16.

<sup>[3]</sup> I = input; O = output; I/O = digital input/output; OD = open-drain output; AI = analog input; AO = analog output; AI/O = analog input/output; P = power or ground pin.

<sup>[4]</sup> A detailed description of these pins can be found in Section 7.9.

# 7. Functional description

#### 7.1 ULPI interface controller

The ISP1504 provides a 12-pin interface that is compliant with *UTMI+ Low Pin Interface* (*ULPI*) Specification Rev. 1.1. This interface must be connected to the USB link.

The ULPI interface controller provides the following functions:

- ULPI-compliant interface and register set
- Allows full control over the USB peripheral, host and OTG functionality
- Parses the USB transmit and receive data
- Prioritizes the USB receive data, USB transmit data, interrupts and register operations
- Low-power mode
- Control of the V<sub>BUS</sub> charge pump or external source
- V<sub>BUS</sub> monitoring, charging and discharging
- 6-pin serial mode and 3-pin serial mode
- Generates RXCMDs; status updates
- Maskable interrupts
- Control over the ULPI bus state, allowing pins to 3-state or attach active weak pull-down resistors

For more information on the ULPI protocol, see Section 9.

#### 7.2 USB data serializer and deserializer

The USB data serializer prepares data to transmit on the USB bus. To transmit data, the USB link sends a transmit command and data on the ULPI bus. The serializer performs parallel-to-serial conversion, bit stuffing and NRZI encoding. For packets with a PID, the serializer adds a SYNC pattern to the start of the packet, and an EOP pattern to the end of the packet. When the serializer is busy and cannot accept any more data, the ULPI interface controller de-asserts NXT.

The USB data deserializer decodes data received from the USB bus. When data is received, the deserializer strips the SYNC and EOP patterns, and then performs serial-to-parallel conversion, NRZI decoding and discarding of stuff bits on the data payload. The ULPI interface controller sends data to the USB link by asserting DIR, and then asserting NXT whenever a byte is ready. The deserializer also detects various receive errors, including bit stuff errors, elasticity buffer underrun or overrun, and byte-alignment errors.

## 7.3 Hi-Speed USB (USB 2.0) ATX

The Hi-Speed USB ATX block is an analog front-end containing the circuitry needed to transmit, receive and terminate the USB bus in high-speed, full-speed and low-speed, for USB peripheral, host and OTG implementations. The following circuitry is included:

• Differential drivers to transmit data at high-speed, full-speed and low-speed

- Differential receiver and single-ended receivers to receive data at high-speed, full-speed and low-speed
- Squelch circuit to detect high-speed bus activity
- High-speed disconnect detector
- 45  $\Omega$  high-speed bus terminations on DP and DM for peripheral and host modes
- 1.5 k $\Omega$  pull-up resistor on DP for full-speed peripheral mode
- 15  $k\Omega$  bus terminations on DP and DM for host and OTG modes

For details on controlling resistor settings, see Table 8.

## 7.4 Voltage regulator

The ISP1504 contains a built-in voltage regulator that conditions the  $V_{CC}$  supply for use inside the ISP1504. The voltage regulator:

- Supports input supply range of 3.0 V < V<sub>CC</sub> < 3.6 V</li>
- Supplies internal circuitry with 1.8 V and 3.3 V

**Remark:** The REG1V8 and REG3V3 pins require external decoupling capacitors. For details, see Section 16.

## 7.5 Crystal oscillator and PLL

The ISP1504 has a built-in crystal oscillator and a Phase-Locked Loop (PLL) for clock generation.

The crystal oscillator takes a sine-wave input from an external crystal, on the XTAL1 pin, and converts it to a square wave clock for internal use. Alternatively, a square wave clock of the same frequency can also be directly driven into the XTAL1 pin. Using an existing square wave clock can save the cost of a crystal and also reduce the board size.

The PLL takes the square wave clock from the crystal oscillator and multiplies or divides it into various frequencies for internal use. The PLL can also take a 60 MHz input from the CLOCK pin. This eliminates the need for an external crystal or clock on XTAL1.

The PLL produces the following frequencies, irrespective of the clock source:

- 60 MHz clock for the ULPI interface controller
- 1.5 MHz for the low-speed USB data
- 12 MHz for the full-speed USB data
- 480 MHz for the high-speed USB data
- Other internal frequencies for data conversion and data recovery

#### 7.6 OTG module

This module contains several sub-blocks that provide all the functionality required by the USB OTG specification. Specifically, it provides the following circuits:

• The ID detector to sense the ID pin of the mini-USB cable. The ID pin dictates which device is initially configured as the host and which as the peripheral.

- V<sub>BUS</sub> comparators to determine the V<sub>BUS</sub> voltage level. This is required for the V<sub>BUS</sub> detection, SRP and HNP.
- Resistors to temporarily charge and discharge V<sub>BUS</sub>. This is required for SRP.
- Charge pump to provide 5 V power on V<sub>BUS</sub>. The downstream peripheral can draw its power from the ISP1504 V<sub>BUS</sub>.

#### 7.6.1 ID detector

The ID detector detects which end of the mini-USB cable is plugged in. The detector must first be enabled by setting the ID\_PULLUP register bit to logic 1. If the ISP1504 senses a value on ID that is different from the previously reported value, an RXCMD status update will be sent to the USB link, or an interrupt will be asserted.

- If the mini-B end of the cable is plugged in, the ISP1504 will report that ID\_GND is logic 1. The USB link must change to peripheral mode.
- If the mini-A end of the cable is plugged in, the ISP1504 will report that ID\_GND is logic 0. The USB link must change to host mode.

## 7.6.2 V<sub>BUS</sub> comparators

The ISP1504 provides three comparators,  $V_{BUS}$  valid comparator, session valid comparator and session end comparator, to detect the  $V_{BUS}$  voltage level.

### 7.6.2.1 V<sub>BUS</sub> valid comparator

This comparator is used by hosts and A-devices to determine whether the voltage on  $V_{BUS}$  is at a valid level for operation. The ISP1504 minimum threshold for the  $V_{BUS}$  valid comparator is  $V_{A\_VBUS\_VLD}$ . Any voltage on  $V_{BUS}$  below  $V_{A\_VBUS\_VLD}$  is considered a fault. During power-up, it is expected that the comparator output will be ignored.

#### 7.6.2.2 Session valid comparator

The session valid comparator is a TTL-level input that determines when  $V_{BUS}$  is high enough for a session to start. Peripherals, A-devices and B-devices use this comparator to detect when a session is started. The A-device also uses this comparator to determine when a session is completed. The session valid threshold of the ISP1504 is  $V_{B\_SESS\_VLD}$ , with a hysteresis of  $V_{hys(B\_SESS\_VLD)}$ .

#### 7.6.2.3 Session end comparator

The ISP1504 session end comparator determines when  $V_{BUS}$  is below the B-device session end threshold. The B-device uses this threshold to determine when a session has ended. The session end threshold of the ISP1504 is  $V_{B\ SESS\ END}$ .

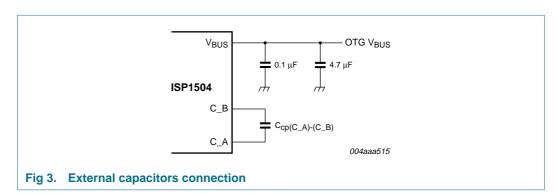
#### 7.6.3 SRP charge and discharge resistors

The ISP1504 provides on-chip resistors for short-term charging and discharging of  $V_{BUS}$ . These are used by the B-device to request a session, prompting the A-device to restore the  $V_{BUS}$  power. First, the B-device makes sure that  $V_{BUS}$  is fully discharged from the previous session by setting the DISCHRG\_VBUS register bit to logic 1 and waiting for SESS\_END to be logic 1. Then the B-device charges  $V_{BUS}$  by setting the CHRG\_VBUS register bit to logic 1. The A-device sees that  $V_{BUS}$  is charged above the session valid threshold and starts a session by turning on the  $V_{BUS}$  power.

## 7.6.4 Charge pump

The ISP1504 uses a built-in charge pump to supply current to V<sub>BUS</sub> at a nominal voltage of 5 V. The charge pump works as a capacitive DC-DC converter. An external holding capacitor, C<sub>cp(C\_A)-(C\_B)</sub>, is required between the C\_A and C\_B pins as shown in Figure 3, which also shows a typical OTG V<sub>BUS</sub> load. The value of C<sub>CD(C A)-(C B)</sub> depends on the amount of current drive required. If the internal charge pump is not used, the C<sub>cp(C,A)-(C,B)</sub> capacitor is not required.

For details on the C\_A and C\_B pins, see Section 7.9.8.



# 7.7 Band gap reference voltage

The band gap circuit provides a stable internal voltage reference to bias analog circuitry. The band gap requires an accurate external reference, R<sub>RRFF</sub>, resistor connected between the RREF pin and GND. For details, see Section 16.

## 7.8 Power-On Reset (POR)

The ISP1504 has an internal power-on reset circuit that resets all internal logic on power-up. The ULPI interface is also reset on power-up.

Remark: When CLOCK starts toggling after power-up, the USB link must issue a reset command over the ULPI bus to ensure correct operation of the ISP1504.

## 7.9 Detailed description of pins

## 7.9.1 DATA[7:0]

Bidirectional data bus. The USB link must drive DATA[7:0] to LOW when the ULPI bus is idle. When the link has data to transmit to the PHY, it drives a nonzero value.

The data bus can be reconfigured to carry various data types, as given in Section 8 and Section 9.

The DATA[7:0] pins can be 3-stated by driving pin CHIP\_SELECT\_N to HIGH. Weak pull-down resistors are incorporated into the DATA[7:0] pins as part of the interface protect feature. For details, see Section 9.3.1.

## 7.9.2 $V_{CC(I/O)}$

The input power pin that sets the I/O voltage level. For details, see Section 12, Section 13 and Section 16. V<sub>CC(I/O)</sub> provides power to on-chip pads of the following pins:

- CHIP\_SELECT\_N
- CLOCK
- DATA[7:0]
- DIR
- NXT
- RESET N
- STP

If the ISP1504 CLOCK pin is configured as an input, the  $V_{CC(I/O)}$  power must be provided at the same time as the  $V_{CC}$  power. If the  $V_{CC(I/O)}$  power input is delayed with respect to  $V_{CC}$ , input clock mode stability cannot be guaranteed.

#### 7.9.3 RREF

Resistor reference analog I/O pin. A resistor, R<sub>RREF</sub>, must be connected between RREF and GND, as shown in <u>Section 16</u>. This provides an accurate voltage reference that biases internal analog circuitry. Less accurate resistors cannot be used and will render the ISP1504 unusable.

#### 7.9.4 DP and DM

The DP (data plus) and DM (data minus) are USB differential data pins. These must be connected to the D+ and D- pins of the USB receptacle.

#### 7.9.5 **FAULT**

If an external  $V_{BUS}$  overcurrent or fault circuit is used, the output fault indicator of that circuit can be connected to the ISP1504 FAULT input pin. The ISP1504 will inform the link of  $V_{BUS}$  fault events by sending RXCMDs on the ULPI bus. To use the FAULT pin, the link must:

- Set the USE EXT VBUS IND register bit to logic 1.
- Set the polarity of the external fault signal using the IND\_COMPL register bit.
- Set the IND PASSTHRU register bit to logic 1.

If the FAULT pin is not used, it is recommended to connect to GND.

#### 7.9.6 ID

For OTG implementations, the ID (identification) pin is connected to the ID pin of the mini-USB receptacle. As defined in *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2*, the ID pin dictates the initial role of the link. If ID is detected as HIGH, the link must assume the role of a peripheral. If ID is detected as LOW, the link must assume a host role. Roles can be swapped at a later time by using HNP.

If the ISP1504 is not used as an OTG PHY, but as a standard USB host or peripheral PHY, the ID pin must be connected to ground.

#### 7.9.7 **CPGND**

CPGND indicates the analog ground for the on-board charge pump. CPGND must always be connected to ground, even when the charge pump is not used.

#### 7.9.8 C A and C B

The C\_A and C\_B pins are to connect the flying capacitor of the charge pump. The output current capability of the charge pump depends on the value of capacitor used, as shown in Table 3. For maximum efficiency, place capacitors as close as possible to pins. For details, see Section 16.

If the charge pump is not used, C\_A and C\_B must be left floating (not connected).

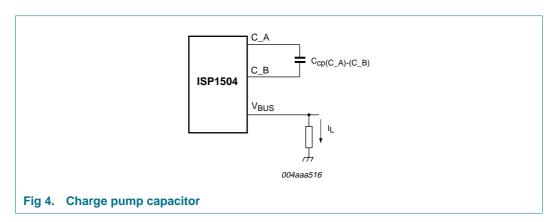


Table 3. Recommended charge pump capacitor value

| $C_{cp(C_A)-(C_B)}$ | I <sub>L</sub> (max) |
|---------------------|----------------------|
| 22 nF               | 8 mA                 |
| 270 nF              | 50 mA                |

#### 7.9.9 V<sub>CC</sub>

 $V_{CC}$  is the main input supply voltage for the ISP1504. Decoupling capacitors are recommended. For details, see Section 16.

## 7.9.10 PSW\_N

PSW\_N is an active LOW, open-drain output pin. This pin can be connected to an active LOW, external V<sub>BUS</sub> switch or charge pump enable circuit to control the external V<sub>BUS</sub> power source. An external pull-up resistor, R<sub>pullup</sub>, is required when PSW\_N is used. This pin is open-drain, allowing ganged-mode power control for multiple USB ports. For application details, see Section 16.

If the link is in host mode, it can enable the external V<sub>BUS</sub> power source by setting the DRV\_VBUS\_EXT bit in the OTG Control register to logic 1. The ISP1504 will drive PSW\_N to LOW to enable the external V<sub>BUS</sub> power source. If the link detects an overcurrent condition (the V<sub>BUS</sub> state in RXCMD is not 11b), it must disable the external V<sub>BUS</sub> power source by setting DRV\_VBUS\_EXT to logic 0.

## 7.9.11 V<sub>BUS</sub>

This pin acts as an input to V<sub>BUS</sub> comparators, and also as a power pin for the charge pump, and SRP charge and discharge resistors.

When the DRV\_VBUS bit of the OTG Control register is set to logic 1, the ISP1504 drives V<sub>BUS</sub> to a voltage of 4.4 V to 5.25 V, with a minimum output current capability of 8 mA.

The V<sub>BUS</sub> pin requires a capacitive load as shown in Section 16.

To prevent electrical overstress, it is strongly recommended that you attach a series resistor on the  $V_{BUS}$  pin ( $R_{VBUS}$ ).  $R_{VBUS}$  must not be attached when using the ISP1504 internal charge pump. For details, see Section 16.

#### 7.9.12 REG3V3 and REG1V8

Regulator output voltage. These supplies are used to power the ISP1504 internal digital and analog circuits, and must not be used to power external circuits.

For correct operation of the regulator, it is recommended that you connect REG3V3 and REG1V8 to decoupling capacitors. For examples, see Section 16.

#### 7.9.13 XTAL1 and XTAL2

XTAL1 is the crystal input, and XTAL2 is the crystal output. The allowed frequency on the XTAL1 pin depends on the ISP1504 product version.

If the link requires a 60 MHz clock from the ISP1504, then either a crystal must be attached, or a clock of the same frequency must be driven into XTAL1, with XTAL2 left floating. If the link drives a 60 MHz clock into the CLOCK pin, then XTAL1 must be connected to REG1V8, and XTAL2 must be left floating.

If a crystal is attached, it requires external load capacitors to GND on each terminal of the crystal. For details, see Section 16.

If at any time the system wants to stop the clock on XTAL1, the link must first put the ISP1504 into low-power mode. The clock on XTAL1 must be restarted before low-power mode is exited.

## 7.9.14 RESET\_N

An active LOW asynchronous reset pin that resets all circuits in the ISP1504. The ISP1504 contains an internal power-on reset circuit, and therefore using the RESET\_N pin is optional. If RESET\_N is not used, it must be connected to  $V_{CC(I/O)}$ .

For details on using RESET\_N, see Section 9.3.2.

#### 7.9.15 DIR

ULPI direction output pin. Controls the direction of the data bus. By default, the ISP1504 holds DIR at LOW, causing the data bus to be an input. When DIR is LOW, the ISP1504 listens for data from the link. The ISP1504 pulls DIR to HIGH only when it has data to send to the link, which is for one of two reasons:

- To send the USB receive data, RXCMD status updates and register read data to the link.
- To block the link from driving the data bus during power-up, reset and low-power mode (suspend).

The DIR pin can also be 3-stated by driving CHIP\_SELECT\_N to HIGH.

For details on DIR usage, refer to UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.

#### 7.9.16 STP

ULPI stop input pin. The link must assert STP to signal the end of a USB transmit packet or a register write operation. When DIR is asserted, the link can optionally assert STP to abort the ISP1504, causing it to de-assert DIR in the next clock cycle. A weak pull-up resistor is incorporated into the STP pin as part of the interface protect feature. For details, see Section 9.3.1.

The STP input will be ignored when CHIP\_SELECT\_N is driven to HIGH.

For details on STP usage, refer to UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.

## 7.9.17 NXT

ULPI next data output pin. The ISP1504 holds NXT at LOW, by default. When DIR is LOW and the link is sending data to the ISP1504, NXT will be asserted to notify the link to provide the next data byte. When DIR is at HIGH and the ISP1504 is sending data to the link, NXT will be asserted to notify the link that another valid byte is on the bus. NXT is not used for register read data or the RXCMD status update.

The NXT pin can also be 3-stated by driving CHIP\_SELECT\_N to HIGH.

For details on NXT usage, refer to UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.

#### 7.9.18 CLOCK

A 60 MHz interface clock to synchronize the ULPI bus. CLOCK can be configured as input or output. The ISP1504 provides three clocking options:

- A crystal attached between the XTAL1 and XTAL2 pins.
- A clock driven into the XTAL1 pin, with the XTAL2 pin left floating.
- A 60 MHz clock driven into the CLOCK pin, with XTAL1 tied to REG1V8 and XTAL2 left floating.

For details on CLOCK usage, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

#### 7.9.19 CHIP SELECT N

Active LOW chip select pin. If CHIP\_SELECT\_N is not used, it must be tied to GND. For more information on using CHIP\_SELECT\_N, see <a href="Section 9.3.3">Section 9.3.3</a>.

## 7.9.20 GND (die pad)

Global ground signal, except for the charge pump that uses CPGND. The die pad is exposed on the underside of the package as a ground plate. This acts as a ground to all circuits in the ISP1504, except the charge pump. To ensure correct operation of the ISP1504, GND must be soldered to the cleanest ground available.

## 8. Modes of operation

#### 8.1 ULPI modes

The ISP1504 ULPI bus can be programmed to operate in four modes. Each mode reconfigures the signals on the data bus as described in the following subsections. Setting more than one mode will lead to undefined behavior.

## 8.1.1 Synchronous mode

This is default mode. At power-up, and when CLOCK is stable, the ISP1504 will enter synchronous mode. The link must synchronize all ULPI signals to CLOCK, meeting the set-up and hold times as defined in <u>Section 15</u>. A description of the ULPI pin behavior in synchronous mode is given in <u>Table 4</u>.

This mode is used by the link to perform the following tasks:

- High-speed detection handshake (chirp)
- Transmit and receive USB packets
- Read and write to registers
- Receive USB status updates (RXCMDs)

For more information on various synchronous mode protocols, see Section 9.

Table 4. ULPI signal description

| Signal name | Direction on ISP1504 | Signal description   |
|-------------|----------------------|--|
| CLOCK       | I/O                  | <b>60 MHz interface clock</b> . If a crystal is attached or a clock is driven into the XTAL1 pin, the ISP1504 will drive a 60 MHz output clock; otherwise, the ISP1504 requires a 60 MHz input clock.  |
| DATA[7:0]   | I/O                  | 8-bit data bus. In synchronous mode, the link drives DATA[7:0] to LOW by default. The link initiates transfers by sending a nonzero data pattern called TXCMD (transmit command). In synchronous mode, the direction of DATA[7:0] is controlled by DIR. Contents of DATA[7:0] lines must be ignored for exactly one clock cycle whenever DIR changes value. This is called the turnaround cycle.  Data lines have fixed direction and different meaning in low-power and serial modes. |

Table 4. ULPI signal description ... continued

| Table 4.    | ULPI Signal (        | ULPI signal descriptioncontinued   |  |  |  |  |  |  |
|-------------|----------------------|--|--|--|--|--|--|--|
| Signal name | Direction on ISP1504 | Signal description   |  |  |  |  |  |  |
| DIR         | 0                    | Direction: Controls the direction of data bus DATA[7:0]. In synchronous mode, the ISP1504 drives DIR to LOW by default, making the data bus an input so that the ISP1504 can listen for TXCMDs from the link. The ISP1504 drives DIR to HIGH only when it has data for the link. When DIR and NXT are HIGH, the byte on the data bus contains decoded USB data. When DIR is HIGH and NXT is LOW, the byte contains status information called RXCMD (receive command). The only exception to this rule is when the PHY returns register read data, where NXT is also LOW, replacing the usual RXCMD byte. Every change in DIR causes a turnaround cycle on the data bus, during which DATA[7:0] is not valid and must be ignored by the link. |  |  |  |  |  |  |
|             |                      | DIR is always asserted during low-power and serial modes.  |  |  |  |  |  |  |
| STP         | 1                    | <b>Stop</b> : In synchronous mode, the link drives STP to HIGH for one cycle after the last byte of data is sent to the ISP1504. The link can optionally assert STP to force DIR to be de-asserted.  |  |  |  |  |  |  |
|             |                      | In low-power and serial modes, the link holds STP at HIGH to wake up the ISP1504, causing the ULPI bus to return to synchronous mode.  |  |  |  |  |  |  |
| NXT         | O                    | <b>Next</b> : In synchronous mode, the ISP1504 drives NXT to HIGH to throttle data. If DIR is LOW, the ISP1504 asserts NXT to notify the link to place the next data byte on DATA[7:0] in the following clock cycle. If DIR is HIGH, the ISP1504 asserts NXT to notify the link that a valid USB data byte is on DATA[7:0] in the current cycle. The ISP1504 always drives an RXCMD when DIR is HIGH and NXT is LOW, unless register read data is to be returned to the link in the current cycle.   |  |  |  |  |  |  |

## 8.1.2 Low-power mode

During low-power mode, the clock on XTAL1 may be stopped. The clock must be started again before asserting STP to exit low-power mode. After exiting low-power mode, the ISP1504 will send an RXCMD to the link if a change was detected in any interrupt source, and the change still exists. An RXCMD may not be sent if the interrupt condition is removed before exiting.

For more information on low-power mode enter and exit protocols, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.* 

Table 5. Signal mapping during low-power mode

| Signal     | Maps to | Direction | Description   |
|------------|---------|-----------|---|
| LINESTATE0 | DATA0   | 0         | combinatorial LINESTATE0 directly driven by analog receiver |
| LINESTATE1 | DATA1   | 0         | combinatorial LINESTATE1 directly driven by analog receiver |

 Table 5.
 Signal mapping during low-power mode ...continued

| Signal   | Maps to   | Direction | Description   |
|----------|-----------|-----------|---|
| Reserved | DATA2     | 0         | reserved; the ISP1504 will drive this pin to LOW  |
| INT      | DATA3     | 0         | active HIGH interrupt indication; will be asserted whenever any unmasked interrupt occurs |
| Reserved | DATA[7:4] | 0         | reserved; the ISP1504 will drive this pin to LOW  |

## 8.1.3 6-pin full-speed or low-speed serial mode

If the link requires a 6-pin serial interface to transmit and receive full-speed or low-speed USB data, it can set the ISP1504 to 6-pin serial mode. In 6-pin serial mode, the DATA[7:0] bus definition changes to that shown in <a href="Table 6">Table 6</a>. To enter 6-pin serial mode, the link sets the 6PIN\_FSLS\_SERIAL bit in the Interface Control register to logic 1. To exit 6-pin serial mode, the link asserts STP. This is provided primarily for links that contain legacy full-speed or low-speed functionality, providing a more cost-effective upgrade path to high-speed. An interrupt pin is also provided to inform the link of USB events. If the link requires CLOCK to be running during 6-pin serial mode, the CLOCK\_SUSPENDM register bit must be set to logic 1.

For more information on 6-pin serial mode enter and exit protocols, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

Table 6. Signal mapping for 6-pin serial mode

|           |         | -         |   |
|-----------|---------|-----------|---|
| Signal    | Maps to | Direction | Description   |
| TX_ENABLE | DATA0   | 1         | active HIGH transmit enable   |
| TX_DAT    | DATA1   | I         | transmit differential data on DP and DM   |
| TX_SE0    | DATA2   | I         | transmit single-ended zero on DP and DM   |
| INT       | DATA3   | 0         | active HIGH interrupt indication; will be asserted whenever any unmasked interrupt occurs |
| RX_DP     | DATA4   | 0         | single-ended receive data from DP   |
| RX_DM     | DATA5   | 0         | single-ended receive data from DM   |
| RX_RCV    | DATA6   | 0         | differential receive data from DP and DM  |
| Reserved  | DATA7   | 0         | reserved; the ISP1504 will drive this pin to LOW  |

## 8.1.4 3-pin full-speed or low-speed serial mode

If the link requires a 3-pin serial interface to transmit and receive full-speed or low-speed USB data, it can set the ISP1504 to 3-pin serial mode. In 3-pin serial mode, the data bus definition changes to that shown in <a href="Table 7">Table 7</a>. To enter 3-pin serial mode, the link sets the 3PIN\_FSLS\_SERIAL bit in the Interface Control register to logic 1. To exit 3-pin serial mode, the link asserts STP. This is primarily provided for links that contain legacy full-speed or low-speed functionality, providing a more cost-effective upgrade path to high-speed. An interrupt pin is also provided to inform the link of USB events. If the link requires CLOCK to be running during 3-pin serial mode, the CLOCK\_SUSPENDM register bit must be set to logic 1.

For more information on 3-pin serial mode enter and exit protocols, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.

Table 7. Signal mapping for 3-pin serial mode

| Signal    | Maps to   | Direction | Description   |
|-----------|-----------|-----------|---|
| TX_ENABLE | DATA0     | I         | active HIGH transmit enable   |
| DAT       | DATA1     | I/O       | transmit differential data on DP and DM when TX_ENABLE is HIGH receive differential data from DP and DM when TX_ENABLE is LOW |
| SE0       | DATA2     | I/O       | transmit single-ended zero on DP and DM when TX_ENABLE is HIGH receive single-ended zero from DP and DM when TX_ENABLE is LOW |
| INT       | DATA3     | 0         | active HIGH interrupt indication; will be asserted whenever any unmasked interrupt occurs                                     |
| Reserved  | DATA[7:4] | 0         | reserved; the ISP1504 will drive this pin to LOW  |

## 8.2 USB and OTG state transitions

A Hi-Speed USB host or an OTG device handles more than one electrical state as defined in *Universal Serial Bus Specification Rev. 2.0* and *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2*. The ISP1504 accommodates the various states through register bit settings of XCVRSELECT[1:0], TERMSELECT, OPMODE[1:0], DP\_PULLDOWN and DM\_PULLDOWN.

<u>Table 8</u> summarizes operating states. The values of register settings in <u>Table 8</u> will force resistor settings as also given in <u>Table 8</u>. Resistor setting signals are defined as follows:

- RPU\_DP\_EN enables the 1.5 kΩ pull-up resistor on DP
- RPD DP EN enables the 15 k $\Omega$  pull-down resistor on DP
- RPD DM EN enables the 15 k $\Omega$  pull-down resistor on DM
- HSTERM\_EN enables the 45  $\Omega$  termination resistors on DP and DM

It is up to the link to set the desired register settings.

Table 8. Operating states and their corresponding resistor settings

| Signaling mode  | Register                | settings       |                 |                 |                 | Internal resistor settings |               |               |               |
|---|-------------------------|----------------|-----------------|-----------------|-----------------|----------------------------|---------------|---------------|---------------|
|   | XCVR<br>SELECT<br>[1:0] | TERM<br>SELECT | OPMODE<br>[1:0] | DP_PULL<br>DOWN | DM_PULL<br>DOWN | RPU_<br>DP_EN              | RPD_<br>DP_EN | RPD_<br>DM_EN | HSTERM<br>_EN |
| General settings  |                         |                |                 |                 |                 |                            |               |               |               |
| 3-state drivers   | XXb                     | Xb             | 01b             | Xb              | Xb              | 0b                         | 0b            | 0b            | 0b            |
| Power-up or<br>V <sub>BUS</sub> < V <sub>B_SESS_END</sub> | 01b                     | 0b             | 00b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 0b            |
| Host settings   |                         |                |                 |                 |                 |                            |               |               |               |
| Host chirp  | 00b                     | 0b             | 10b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 1b            |
| Host high-speed   | 00b                     | 0b             | 00b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 1b            |
| Host full-speed   | X1b                     | 1b             | 00b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 0b            |
| Host high-speed or full-speed suspend                     | 01b                     | 1b             | 00b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 0b            |
| Host high-speed or full-speed resume                      | 01b                     | 1b             | 10b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 0b            |
| Host low-speed  | 10b                     | 1b             | 00b             | 1b              | 1b              | 0b                         | 1b            | 1b            | 0b            |

 Table 8.
 Operating states and their corresponding resistor settings ...continued

| Signaling mode   | Register settings       |                |                 |                 |                 |               | Internal resistor settings |               |               |  |
|--|-------------------------|----------------|-----------------|-----------------|-----------------|---------------|----------------------------|---------------|---------------|--|
|  | XCVR<br>SELECT<br>[1:0] | TERM<br>SELECT | OPMODE<br>[1:0] | DP_PULL<br>DOWN | DM_PULL<br>DOWN | RPU_<br>DP_EN | RPD_<br>DP_EN              | RPD_<br>DM_EN | HSTERM<br>_EN |  |
| Host low-speed suspend   | 10b                     | 1b             | 00b             | 1b              | 1b              | 0b            | 1b                         | 1b            | 0b            |  |
| Host low-speed resume  | 10b                     | 1b             | 10b             | 1b              | 1b              | 0b            | 1b                         | 1b            | 0b            |  |
| Host Test J or Test K  | 00b                     | 0b             | 10b             | 1b              | 1b              | 0b            | 1b                         | 1b            | 1b            |  |
| Peripheral settings  |                         |                |                 |                 |                 |               |                            |               |               |  |
| Peripheral chirp   | 00b                     | 1b             | 10b             | 0b              | 0b              | 1b            | 0b                         | 0b            | 0b            |  |
| Peripheral<br>high-speed   | 00b                     | 0b             | 00b             | 0b              | 0b              | 0b            | 0b                         | 0b            | 1b            |  |
| Peripheral full-speed  | 01b                     | 1b             | 00b             | 0b              | 0b              | 1b            | 0b                         | 0b            | 0b            |  |
| Peripheral<br>high-speed or<br>full-speed suspend                | 01b                     | 1b             | 00b             | 0b              | 0b              | 1b            | 0b                         | 0b            | 0b            |  |
| Peripheral<br>high-speed or<br>full-speed resume                 | 01b                     | 1b             | 10b             | 0b              | 0b              | 1b            | 0b                         | 0b            | 0b            |  |
| Peripheral Test J or<br>Test K                                   | 00b                     | 0b             | 10b             | 0b              | 0b              | 0b            | 0b                         | 0b            | 1b            |  |
| OTG settings   |                         |                |                 |                 |                 |               |                            |               |               |  |
| OTG device peripheral chirp                                      | 00b                     | 1b             | 10b             | 0b              | 1b              | 1b            | 0b                         | 1b            | 0b            |  |
| OTG device<br>peripheral<br>high-speed                           | 00b                     | 0b             | 00b             | 0b              | 1b              | 0b            | 0b                         | 1b            | 1b            |  |
| OTG device peripheral full-speed                                 | 01b                     | 1b             | 00b             | 0b              | 1b              | 1b            | 0b                         | 1b            | 0b            |  |
| OTG device<br>peripheral<br>high-speed and<br>full-speed suspend | 01b                     | 1b             | 00b             | 0b              | 1b              | 1b            | 0b                         | 1b            | 0b            |  |
| OTG device<br>peripheral<br>high-speed and<br>full-speed resume  | 01b                     | 1b             | 10b             | 0b              | 1b              | 1b            | 0b                         | 1b            | 0b            |  |
| OTG device<br>peripheral Test J or<br>Test K                     | 00b                     | 0b             | 10b             | 0b              | 1b              | 0b            | 0b                         | 1b            | 1b            |  |

# 9. Protocol description

The following subsections describe the protocol for using the ISP1504.

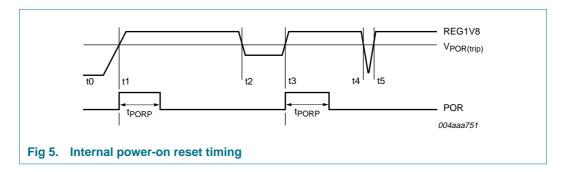
#### 9.1 ULPI references

The ISP1504 provides a 12-pin ULPI interface to communicate with the link. It is highly recommended that you read *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1* and *UTMI+ Specification Rev. 1.0*.

## 9.2 Power-On Reset (POR)

An internal POR is generated when REG1V8 rises above  $V_{POR(trip)}$ , for at least  $t_{w(REG1V8\_H)}$ . The internal POR pulse will also be generated whenever REG1V8 drops below  $V_{POR(trip)}$  for more than  $t_{w(REG1V8\_L)}$ , and then rises above  $V_{POR(trip)}$  again. The voltage on REG1V8 is generated from  $V_{CC}$ .

To give a better view of the functionality, Figure 5 shows a possible curve of REG1V8. The internal POR starts with logic 0 at t0. At t1, the detector will see the passing of the trip level so that POR turns to logic 1 and a delay element will add another  $t_{PORP}$  before it drops to logic 0. If REG1V8 dips from t2 to t3 for >  $t_{W(REG1V8\_L)}$ , another POR pulse is generated. If the dip at t4 to t5 is too short, that is, <  $t_{W(REG1V8\_L)}$ , the internal POR pulse will not react and will remain LOW.



## 9.3 Power-up, reset and bus idle sequence

Figure 6 shows a typical start-up sequence.

On power-up, the ISP1504 performs an internal power-on reset and asserts DIR to indicate to the link that the ULPI bus cannot be used. On power-up, CLOCK is an input unless several edges are detected on XTAL1. When the internal PLL is stable, the ISP1504 de-asserts DIR. The power-up time depends on the  $V_{CC}$  supply rise time, the crystal start-up time, and PLL start-up time  $t_{startup(o)(CLOCK)}$ . Whenever DIR is asserted, the ISP1504 drives the NXT pin to LOW and drives DATA[7:0] with RXCMD values. When DIR is de-asserted, the link must drive the data bus to a valid level. By default, the link must drive data to LOW. When the ISP1504 initially de-asserts DIR on power-up, the link must ignore all RXCMDs until it resets the ISP1504. Before beginning USB packets, the link must set the RESET bit in the Function Control register to reset the ISP1504. After the RESET bit is set, the ISP1504 will assert DIR until the internal reset completes. The ISP1504 will automatically de-assert DIR and clear the RESET bit when reset has

# ISP1504A; ISP1504C

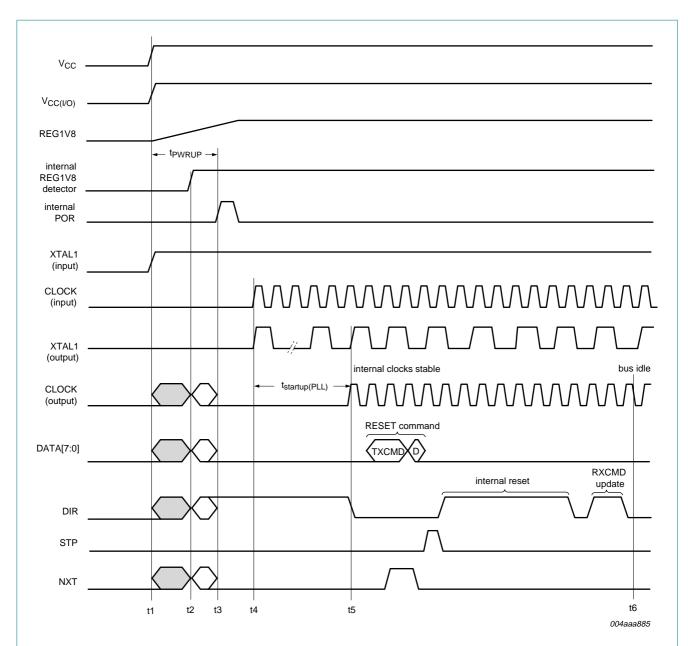
**ULPI HS USB OTG transceiver** 

completed. After every reset, an RXCMD is sent to the link to update USB status information. After this sequence, the ULPI bus is ready for use and the link can start USB operations.

If a crystal is attached or a clock is driven into the XTAL1 pin, the ISP1504 will drive a 60 MHz clock out from the CLOCK pin when DIR de-asserts. This is shown as CLOCK (output) in Figure 6. If no crystal is attached and a 60 MHz clock is driven into the CLOCK pin, DIR will de-assert when internal clocks have synchronized. This is shown as CLOCK (input) in Figure 6.

The recommended power-up sequence for the link is as follows:

- The link waits for 1 ms, ignoring all the ULPI pin status.
- The link may start to detect DIR status level. If DIR is detected as LOW for three clock cycles, the link may send a RESET command.
- The ULPI interface is ready for use.



 $t1 = V_{CC}$  and  $V_{CC(I/O)}$  are applied to the ISP1504. The ISP1504 regulator starts to turn on. If the ISP1504 CLOCK pin is configured as an input, the  $V_{CC(I/O)}$  power must be provided at the same time as the  $V_{CC}$  power. If the  $V_{CC(I/O)}$  power input is delayed with respect to  $V_{CC}$ , input clock mode stability cannot be guaranteed.

t2 = ULPI pads detect REG1V8 rising above the REG1V8 regulator threshold and are not in 3-state. These pads may drive either LOW or HIGH. It is recommended that the link ignores the ULPI pins status during tpwRUP.

t3 = The POR threshold is reached and a POR pulse is generated. After the POR pulse, ULPI pins are driven to a defined level. DIR is driven to HIGH and the other pins are driven to LOW.

t4 = The 19.2 MHz or 26 MHz input clock starts. This clock may be started any time.

t5 = The internal PLL is stabilized after t<sub>startup(PLL)</sub>. If the 19.2 MHz or 26 MHz clock is started before POR, the internal PLL will be stabilized after t<sub>startup(PLL)</sub> from POR. The CLOCK pin starts to output 60 MHz. The DIR pin will transition from HIGH to LOW. The DIR pin will remain LOW before the link issues a RESET command to the ISP1504.

t6 = The power-up sequence is completed and the ULPI bus interface is ready for use.

Fig 6. Power-up and reset sequence required before the ULPI bus is ready for use

ISP1504A\_ISP1504C\_1 © NXP B.V. 2006. All rights reserved.

## 9.3.1 Interface protection

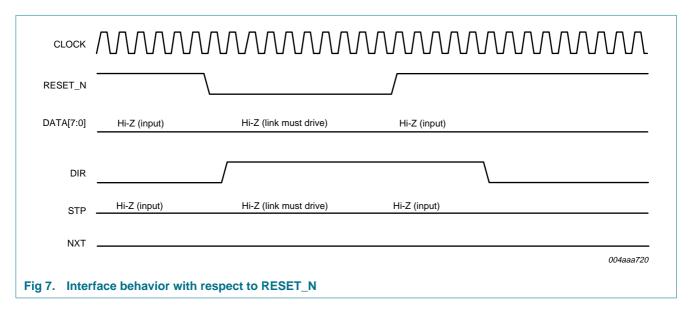
By default, the ISP1504 enables a weak pull-up resistor on STP. If the STP pin is unexpectedly HIGH at any time, the ISP1504 will protect the ULPI interface by enabling weak pull-down resistors on DATA[7:0].

The interface protect feature prevents unwanted activity of the ISP1504 whenever the ULPI interface is not correctly driven by the link. For example, when the link powers up more slowly than the ISP1504.

The interface protect feature can be disabled by setting the INTF\_PROT\_DIS bit to logic 1.

## 9.3.2 Interface behavior with respect to RESET\_N

The use of the RESET\_N pin is optional. When RESET\_N is asserted (LOW), the ISP1504 will assert DIR. All logic in the ISP1504 will be reset, including the analog circuitry and ULPI registers. During reset, the link must drive DATA[7:0] and STP to LOW; otherwise undefined behavior may result. When RESET\_N is de-asserted (HIGH), the DIR output will de-assert (LOW) four or five clock cycles later. Figure 7 shows the ULPI interface behavior when RESET\_N is asserted (LOW), and when RESET\_N is subsequently de-asserted (HIGH). The behavior of Figure 7 applies only when CHIP\_SELECT\_N is asserted (LOW). If RESET\_N is not used, it must be tied to  $V_{CC(I/O)}$ .



#### 9.3.3 Interface behavior with respect to CHIP SELECT N

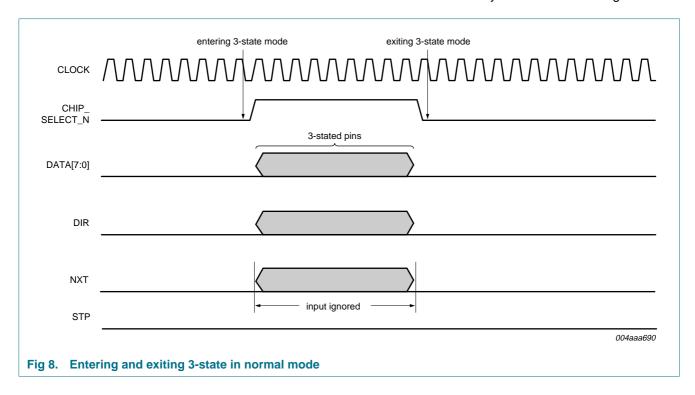
At any time that CHIP\_SELECT\_N is HIGH, the ISP1504 will 3-state DATA[7:0], NXT, and DIR, and the STP input will be ignored. The link can reuse these pins for other purposes.

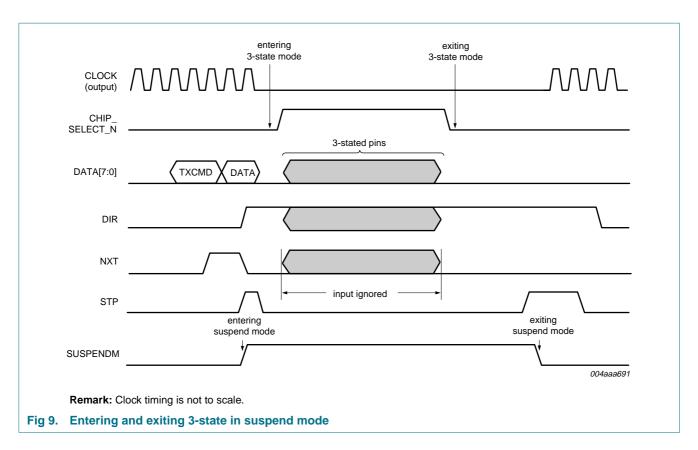
When CHIP\_SELECT\_N is LOW, ULPI output pins operate normally. During normal operation, the PLL is always powered, regardless of the level of CHIP\_SELECT\_N.

During power-up, if CHIP\_SELECT\_N is HIGH, the PLL is not powered up to reduce power consumption. During power-up, if CHIP\_SELECT\_N is LOW, the PLL is powered and the ISP1504 operates normally.

If CHIP SELECT N is HIGH:

- The DATA[7:0], NXT and DIR pins are 3-stated and ignored.
- If the ISP1504 was previously in synchronous mode, the STP pin is ignored. If the ISP1504 was previously in serial or suspend mode, STP is used to exit.
- The pull-down resistors on DATA[7:0] are disabled.
- The ULPI controller is forced into an idle state and any ULPI command is ignored.





## 9.4 V<sub>BUS</sub> power and fault detection

## 9.4.1 Driving 5 V on V<sub>BUS</sub>

The ISP1504 provides a built-in charge pump. To enable the charge pump, the link must set the DRV\_VBUS bit in the OTG Control register.

The ISP1504 also supports external 5 V supplies. The ISP1504 can control the external supply using the active-LOW PSW\_N open-drain output pin. To enable the external supply by driving PSW\_N to LOW, the link must set the DRV\_VBUS\_EXT bit in the OTG Control register to logic 1. The link can optionally set both the DRV\_VBUS and DRV\_VBUS\_EXT bits to logic 1 to enable the external supply.

Table 9 summarizes settings to drive 5 V on V<sub>BUS</sub>.

Table 9. OTG Control register power control bits

| DRV_VBUS | DRV_VBUS_EXT | Power source used   |
|----------|--------------|---|
| 0        | 0            | internal and external V <sub>BUS</sub> power sources are disabled |
| 1        | 0            | internal V <sub>BUS</sub> charge pump is enabled                  |
| Χ        | 1            | external 5 V V <sub>BUS</sub> supply is enabled                   |

#### 9.4.2 Fault detection

The ISP1504 supports external  $V_{BUS}$  fault detector circuits that output a digital fault indicator signal. The indicator signal must be connected to the FAULT pin. To enable the ISP1504 to monitor the digital fault input, the link must set the USE\_EXT\_VBUS\_IND bit in the OTG Control register. By default, the digital indicator is interpreted by the ISP1504

as active LOW. That is, a LOW level on FAULT indicates a V<sub>BUS</sub> fault condition has been detected. If the external fault detector provides an active HIGH digital indicator, the link must set the IND\_COMPL bit in the Interface Control register to logic 1.

By default, the ISP1504 will qualify the external FAULT input with the internal  $V_{BUS}$  valid comparator. This can be disabled by setting the IND PASSTHRU bit to logic 0.

#### 9.5 TXCMD and RXCMD

Commands between the ISP1504 and the link are described in the following subsections.

#### 9.5.1 TXCMD

By default, the link must drive the ULPI bus to its idle state of 00h. To send commands and USB packets, the link drives a nonzero value on DATA[7:0] to the ISP1504 by sending a byte called TXCMD. Commands include USB packet transmissions, and register reads and writes. Once the TXCMD is interpreted and accepted by the ISP1504, the NXT signal is asserted and the link can follow up with the required number of data bytes. The TXCMD byte format is given in Table 10. Any values other than those in Table 10 are illegal and may result in undefined behavior.

Various TXCMD packet and register sequences are shown in later sections.

Table 10. TXCMD byte format

|                    | •                      |                           |              |  |
|--------------------|------------------------|---------------------------|--------------|--|
| Command type name  | Command code DATA[7:6] | Command payload DATA[5:0] | Command name | Command description  |
| Idle               | 00b                    | 00 0000b                  | NOOP         | No operation. 00h is the idle value of the data bus. The link must drive NOOP by default.  |
| Packet<br>transmit | 01b                    | 00 0000b                  | NOPID        | Transmit USB data that does not have a PID, such as chirp and resume signaling. The ISP1504 starts transmitting only after accepting the next data byte. |
|                    |                        | 00 XXXXb                  | PID          | Transmit USB packet. DATA[3:0] indicates USB packet identifier PID[3:0].   |
| Register<br>write  | 10b                    | 10 1111b                  | EXTW         | Extended register write command (optional). The 8-bit address must be provided after the command is accepted.  |
|                    |                        | XX XXXXb                  | REGW         | Register write command with 6-bit immediate address.   |
| Register read      | 11b                    | 10 1111b                  | EXTR         | Extended register read command (optional). The 8-bit address must be provided after the command is accepted.   |
|                    |                        | XX XXXXb                  | REGR         | Register read command with 6-bit immediate address.  |

#### 9.5.2 RXCMD

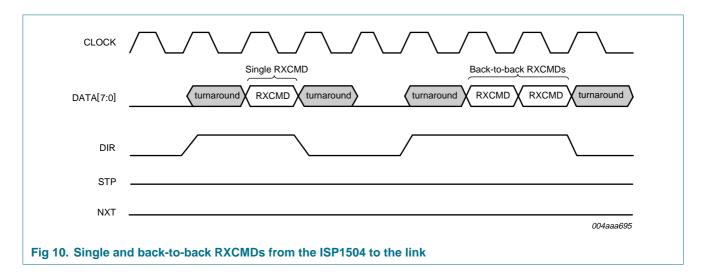
The ISP1504 communicates status information to the link by asserting DIR and sending an RXCMD byte on the DATA bus. The RXCMD data byte format is given in Table 11.

The ISP1504 will automatically send an RXCMD whenever there is a change in any of the RXCMD data fields. The link must be able to accept an RXCMD at any time; including single RXCMDs, back-to-back RXCMDs, and RXCMDs at any time during USB receive packets when NXT is LOW. An example is shown in Figure 10. For details and diagrams, refer to UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.

An RXCMD may not be sent when exiting low-power mode or serial mode, if the interrupt condition is removed before exiting.

Table 11. RXCMD byte format

| DATA   | Name                   | Description and value   |   |                               |                    |            |  |
|--------|------------------------|---|---|-------------------------------|--------------------|------------|--|
| 1 to 0 | LINESTATE              | LINESTATE signals: For a definition of LINESTATE, see Section 9.5.2.1.  DATA0 — LINESTATE[0]  DATA1 — LINESTATE[1]  |   |                               |                    |            |  |
| 3 to 2 | V <sub>BUS</sub> state | Encode  | ed V <sub>BUS</sub> voltage state: For an explana | ation of the V <sub>BUS</sub> | state, see Sectio  | n 9.5.2.2. |  |
|        |                        | Value   | V <sub>BUS</sub> voltage                          | SESS_END                      | SESS_VLD           | A_VBUS_VLD |  |
|        |                        | 00  | V <sub>BUS</sub> < V <sub>B_SESS_END</sub>        | 1                             | 0                  | 0          |  |
|        |                        | 01  | $V_{B\_SESS\_END} \le V_{BUS} < V_{B\_SESS\_VLD}$ | 0                             | 0                  | 0          |  |
|        |                        | 10  | $V_{B\_SESS\_VLD} \le V_{BUS} < V_{A\_VBUS\_VLD}$ | X                             | 1                  | 0          |  |
|        |                        | 11  | $V_{BUS} \ge V_{A\_VBUS\_VLD}$                    | X                             | X                  | 1          |  |
| 5 to 4 | RxEvent                | Encoded USB event signals: For an explanation of RxEvent, see Section 9.5.2.3.  |   |                               |                    |            |  |
|        |                        | Value   | RxActive  | RxError                       | HostDisconr        | nect       |  |
|        |                        | 00  | 0   | 0                             | 0                  |            |  |
|        |                        | 01  | 1   | 0                             | 0                  |            |  |
|        |                        | 11  | 1   | 1                             | 0                  |            |  |
|        |                        | 10  | X   | X                             | 1                  |            |  |
| 6      | ID                     | Set to the value of the ID pin.   |   |                               |                    |            |  |
| 7      | ALT_INT                | T_INT  By default, this signal is not used and is not needed in typical designs. Optionally, the link can enable the BVALID_RISE and/or BVALID_FALL bits in the Power Control register. Correspond changes in BVALID will cause an RXCMD to be sent to the link with the ALT_INT bit asserted |   |                               | ter. Corresponding |            |  |



## 9.5.2.1 Linestate encoding

LINESTATE[1:0] reflects the current state of DP and DM. Whenever the ISP1504 detects a change in DP or DM, an RXCMD will be sent to the link with the new LINESTATE[1:0] value. The value given on LINESTATE[1:0] depends on the setting of various registers.

ISP1504A\_ISP1504C\_1 © NXP B.V. 2006. All rights reserved.

Table 12 shows the LINESTATE[1:0] encoding for upstream facing ports, which applies to peripherals. Table 13 shows the LINESTATE[1:0] encoding for downstream facing ports, which applies to Host Controllers. Dual-role devices must choose the correct table, depending on whether it is in peripheral or host mode.

Table 12. LINESTATE[1:0] encoding for upstream facing ports: peripheral  $DP\_PULLDOWN = 0.17$ 

| Mode            |    | Full-speed | High-speed | Chirp   |
|-----------------|----|------------|------------|---|
| XCVRSELECT[1:0] |    | 01, 11     | 00         | 00  |
| TERMSELECT      |    | 1          | 0          | 1   |
| LINESTATE[1:0]  | 00 | SE0        | squelch    | squelch                                       |
|                 | 01 | FS-J       | !squelch   | !squelch and HS_Differential_Receiver_Output  |
|                 | 10 | FS-K       | invalid    | !squelch and !HS_Differential_Receiver_Output |
|                 | 11 | SE1        | invalid    | invalid                                       |

<sup>[1] !</sup>squelch indicates inactive squelch. !HS\_Differential\_Receiver\_Output indicates inactive HS\_Differential\_Receiver\_Output.

Table 13. LINESTATE[1:0] encoding for downstream facing ports: host DP\_PULLDOWN and DM\_PULLDOWN = 1.[1]

| Mode            |    | Low-speed | Full-speed | High-speed   | Chirp   |
|-----------------|----|-----------|------------|--------------|---|
| XCVRSELECT[1:0] |    | 10        | 01, 11     | 00           | 00  |
| TERMSELECT      |    | 1         | 1          | 0            | 0   |
| OPMODE[1:0]     |    | Χ         | Χ          | 00, 01 or 11 | 10  |
| LINESTATE[1:0]  | 00 | SE0       | SE0        | squelch      | squelch                                       |
|                 | 01 | LS-K      | FS-J       | !squelch     | !squelch and HS_Differential_Receiver_Output  |
|                 | 10 | LS-J      | FS-K       | invalid      | !squelch and !HS_Differential_Receiver_Output |
|                 | 11 | SE1       | SE1        | invalid      | invalid                                       |

<sup>[1] !</sup>squelch indicates inactive squelch. !HS\_Differential\_Receiver\_Output indicates inactive HS\_Differential\_Receiver\_Output.

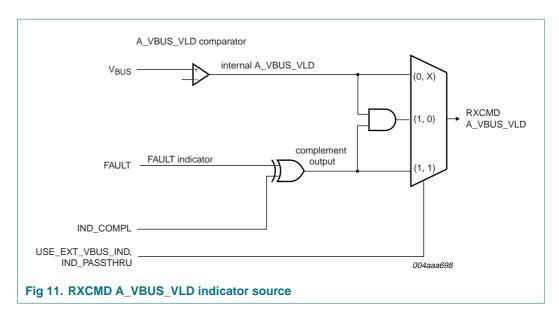
#### 9.5.2.2 V<sub>BUS</sub> state encoding

USB devices must monitor the  $V_{BUS}$  voltage for purposes such as overcurrent detection, starting a session and SRP. The  $V_{BUS}$  state field in the RXCMD is an encoding of the voltage level on  $V_{BUS}$ .

The SESS\_END and SESS\_VLD indicators in the  $V_{BUS}$  state are directly taken from internal comparators built-in to the ISP1504, and encoded as shown in Table 11.

The A\_VBUS\_VLD indicator in the V<sub>BUS</sub> state provides several options and must be configured based on current draw requirements. A\_VBUS\_VLD can input from one or more V<sub>BUS</sub> voltage indicators, as shown in Figure 11.

A description on how to use and select the  $V_{BUS}$  state encoding is given in <u>Section "Using</u> and selecting the  $V_{BUS}$  state encoding".



Using and selecting the  $V_{BUS}$  state encoding: The  $V_{BUS}$  state encoding is shown in Table 11. The ISP1504 will send an RXCMD to the link whenever there is a change in the  $V_{BUS}$  state. To receive the  $V_{BUS}$  state updates, the link must first enable the corresponding interrupts in the USB Interrupt Enable Rising Edge and USB Interrupt Enable Falling Edge registers.

The link can use the  $V_{BUS}$  state to monitor  $V_{BUS}$  and take appropriate action. <u>Table 14</u> shows the recommended usage for typical applications.

Table 14. V<sub>BUS</sub> indicators in RXCMD required for typical applications

| Application         | A_VBUS_VLD | SESS_VLD | SESS_END |
|---------------------|------------|----------|----------|
| Standard host       | yes        | no       | no       |
| Standard peripheral | no         | yes      | no       |
| OTG A-device        | yes        | yes      | no       |
| OTG B-device        | no         | yes      | yes      |

**Standard USB Host Controllers**: For standard hosts, the system must be able to provide 500 mA on  $V_{BUS}$  in the range of 4.75 V to 5.25 V. An external circuit must be used to detect overcurrent conditions. If the external overcurrent detector provides a digital fault signal, then the fault signal should be connected to the ISP1504 FAULT input pin, and the link must do the following:

- 1. If the external overcurrent circuit has an active LOW fault or overcurrent indicator, set the IND\_COMPL bit in the Interface Control register to logic 1.
- 2. Set the USE\_EXT\_VBUS\_IND bit in the OTG Control register to logic 1.
- 3. If it is not necessary to qualify the fault indicator with the internal A\_VBUS\_VLD comparator, set the IND\_PASSTHRU bit in the Interface Control register to logic 1.

**Standard USB Peripheral Controllers**: Standard peripherals must be able to detect when  $V_{BUS}$  is at a sufficient level for operation. SESS\_VLD must be enabled to detect the start and end of USB peripheral operations. Detection of A\_VBUS\_VLD and SESS\_END thresholds is not needed for standard peripherals.

**OTG devices**: When an OTG device is configured as an OTG A-device, it must be able to provide a minimum of 8 mA on  $V_{BUS}$ . If the OTG A-device provides less than 100 mA, then there is no need for an overcurrent detection circuit because the internal A\_VBUS\_VLD comparator is sufficient. If the OTG A-device provides more than 100 mA on  $V_{BUS}$ , an overcurrent detector must be used and "**Standard USB Host Controllers**" applies. The OTG A-device also uses SESS\_VLD to detect when an OTG A-device is initiating  $V_{BUS}$  pulsing SRP.

When an OTG device is configured as an OTG B-device, SESS\_VLD must be used to detect when  $V_{BUS}$  is at a sufficient level for operation. SESS\_END must be used to detect when  $V_{BUS}$  has dropped to a LOW level, allowing the B-device to safely initiate  $V_{BUS}$  pulsing SRP.

#### 9.5.2.3 RxEvent encoding

The RxEvent field of the RXCMD informs the link of information related packets received on the USB bus. RxActive and RxError are defined in *USB 2.0 Transceiver Macrocell Interface (UTMI) Specification Ver. 1.05.* HostDisconnect is defined in *UTMI+ Specification Rev. 1.0.* A short definition is also given in the following subsections.

**RxActive:** When the ISP1504 has detected a SYNC pattern on the USB bus, it signals an RxActive event to the link. An RxActive event can be communicated using two methods. The first method is for the ISP1504 to simultaneously assert DIR and NXT. The second method is for the ISP1504 to send an RXCMD to the link with the RxActive field in RxEvent bits set to logic 1. The link must be able to detect both methods. RxActive frames the receive packet from the first byte to the last byte.

The link must assume that RxActive is set to logic 0 when indicated in an RXCMD or when DIR is de-asserted, whichever occurs first.

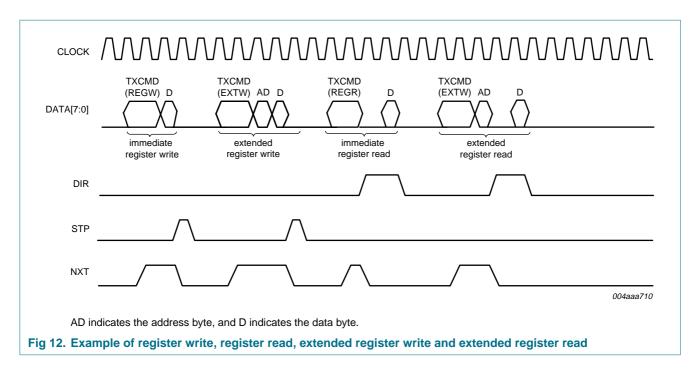
The link uses RxActive to time high-speed packets and ensure that bus turnaround times are met. For more information on the USB packet timing, see Section 9.8.1.

**RxError:** When the ISP1504 has detected an error while receiving a USB packet, it de-asserts NXT and sends an RXCMD with the RxError field set to logic 1. The received packet is no longer valid and must be dropped by the link.

HostDisconnect: HostDisconnect is encoded into the RxEvent field of the RXCMD. HostDisconnect is valid only when the ISP1504 is configured as a host (both DP\_PULLDOWN and DM\_PULLDOWN are set to logic 1), and indicates to the Host Controller when a peripheral is connected or disconnected. The Host Controller must enable HostDisconnect by setting the HOST\_DISCON\_R and HOST\_DISCON\_F bits in the USB Interrupt Enable Rising Edge and USB Interrupt Enable Falling Edge registers, respectively. Changes in HostDisconnect will cause the PHY to send an RXCMD to the link with the updated value.

## 9.6 Register read and write operations

Figure 12 shows register read and write sequences. The ISP1504 supports immediate addressing and extended addressing register operations. Extended register addressing is optional for links. Note that register operations will be aborted if the ISP1504 unexpectedly asserts DIR during the operation. When a register operation is aborted, the link must retry until successful. For more information on register operations, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.



## 9.7 USB reset and high-speed detection handshake (chirp)

<u>Figure 13</u> shows the sequence of events for USB reset and high-speed detection handshake (chirp). The sequence is shown for hosts and peripherals. <u>Figure 13</u> does not show all RXCMD updates and timing is not to scale. The sequence is as follows:

1. USB reset: The host detects a peripheral attachment as low-speed if DM is HIGH and as full-speed if DP is HIGH. If a host detects a low-speed peripheral, it does not follow the remainder of this protocol. If a host detects a full-speed peripheral, it resets the peripheral by writing to the Function Control register and setting XCVRSELECT[1:0] = 00b (high-speed) and TERMSELECT = 0b, which drives SE0 on the bus (DP and DM connected to ground through 45 Ω). The host also sets OPMODE[1:0] = 10b for correct chirp transmit and receive. The start of SE0 is labeled T<sub>0</sub>.

**Remark:** To receive chirp signaling, the host must also consider the high-speed differential receiver output. The Host Controller must interpret LINESTATE[1:0] as shown in Table 13.

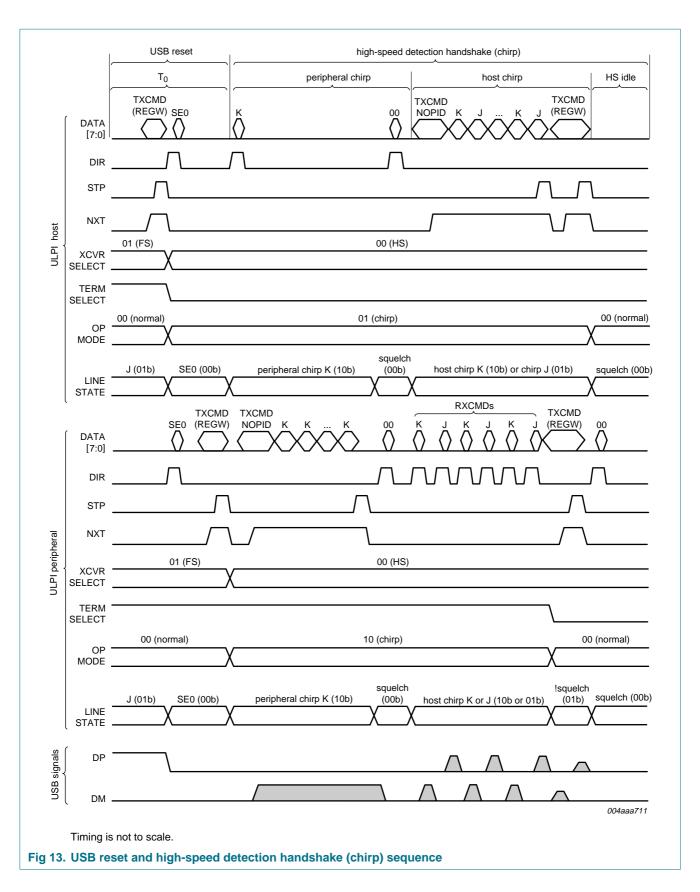
- 2. High-speed detection handshake (chirp)
  - a. Peripheral chirp: After detecting SE0 for no less than 2.5  $\mu$ s, if the peripheral is capable of high-speed, it sets XCVRSELECT[1:0] = 00b (high-speed) and OPMODE[1:0] = 10b (chirp). The peripheral immediately follows this with a TXCMD (NOPID), transmitting a Chirp K for no less than 1 ms and ending no more than 7 ms after reset time T<sub>0</sub>. If the peripheral is in low-power mode, it must wake up its clock within 5.6 ms, leaving 200  $\mu$ s for the link to start transmitting the Chirp K, and 1.2 ms for the Chirp K to complete (worst case with 10 % slow clock).
  - b. Host chirp: If the host does not detect the peripheral chirp, it must continue asserting SE0 until the end of reset. If the host detects the peripheral Chirp K for no less than 2.5  $\mu$ s, then no more than 100  $\mu$ s after the bus leaves the Chirp K

# ISP1504A; ISP1504C

**ULPI HS USB OTG transceiver** 

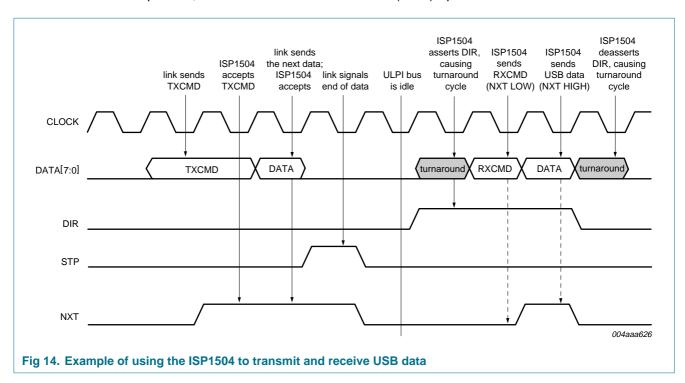
- state, the host sends a TXCMD (NOPID) with an alternating sequence of Chirp Ks and Js. Each Chirp K or Chirp J must last no less than 40  $\mu$ s and no longer than 60  $\mu$ s.
- c. High-speed idle: The peripheral must detect a minimum of Chirp K-J-K-J-K-J. Each Chirp K and Chirp J must be detected for at least 2.5 μs. After seeing that minimum sequence, the peripheral sets TERMSELECT = 0b and OPMODE[1:0] = 00b. The peripheral is now in high-speed mode and sees !squelch (01b on LINESTATE). When the peripheral sees squelch (10b on LINESTATE), it knows that the host has completed chirp and waits for high-speed USB traffic to begin. After transmitting the chirp sequence, the host changes OPMODE[1:0] to 00b and begins sending USB packets.

For more information, refer to UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1.



## 9.8 USB packet transmit and receive

An example of a packet transmit and receive is shown in <u>Figure 14</u>. For details on USB packets, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*.



## 9.8.1 USB packet timing

#### 9.8.1.1 ISP1504 pipeline delays

The ISP1504 delays are shown in <u>Table 15</u>. For detailed description, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*, Section 3.8.2.6.2.

Table 15. PHY pipeline delays

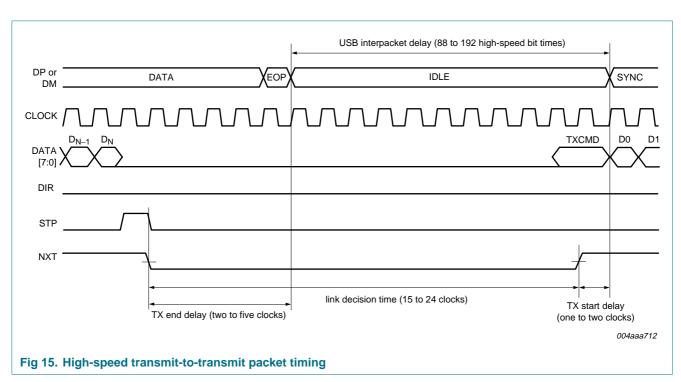
| També de la companya   |                      |                      |                     |
|------------------------|----------------------|----------------------|---------------------|
| Parameter name         | High-speed PHY delay | Full-speed PHY delay | Low-speed PHY delay |
| RXCMD delay (J and K)  | 4                    | 4                    | 4                   |
| RXCMD delay (SE0)      | 4                    | 4 to 6               | 16 to 18            |
| TX start delay         | 1 to 2               | 6 to 10              | 74 to 75            |
| TX end delay (packets) | 3 to 4               | not applicable       | not applicable      |
| TX end delay (SOF)     | 6 to 9               | not applicable       | not applicable      |
| RX start delay         | 5 to 6               | not applicable       | not applicable      |
| RX end delay           | 5 to 6               | 17 to 18             | 122 to 123          |
|                        |                      |                      |                     |

#### 9.8.1.2 Allowed link decision time

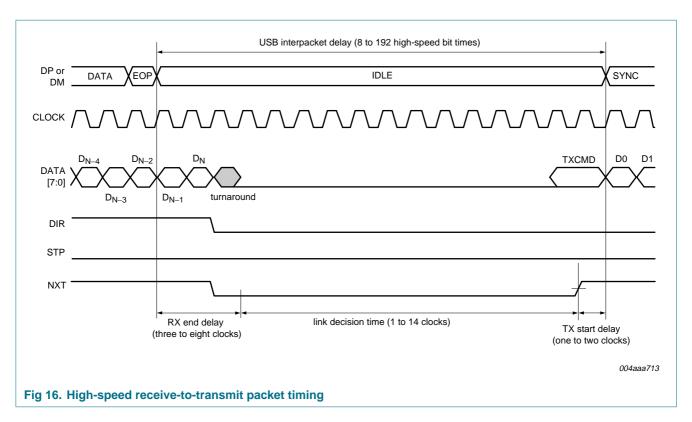
The amount of clock cycles allocated to the link to respond to a received packet and correctly receive back-to-back packets is given in <u>Table 16</u>. Link designs must follow values given in <u>Table 16</u> for correct USB system operation. Examples of high-speed packet sequences and timing are shown in <u>Figure 15</u> and <u>Figure 16</u>. For details, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*, Section 3.8.2.6.3.

Table 16. Link decision times

| Packet sequence                             | High-speed<br>link delay | Full-speed<br>link delay | Low-speed link delay | Definition  |  |
|---|--------------------------|--------------------------|----------------------|---|--|
| Transmit-Transmit (host only)               | 15 to 24                 | 7 to 18                  | 77 to 247            | Number of clocks a host link must wait before driving the TXCMD for the second packet.  |  |
|   |                          |                          |                      | In high-speed, the link starts counting from the assertion of STP for the first packet.   |  |
|   |                          |                          |                      | In full-speed, the link starts counting from the RXCMD, indicating LINESTATE has changed from SE0 to J for the first packet. The timing given ensures inter-packet delays of 2 bit times to 6.5 bit times.                |  |
| Receive-Transmit<br>(host or<br>peripheral) | 1 to 14                  | 7 to 18                  | 77 to 247            | Number of clocks the link must wait before driving the TXCMD for the transmit packet.   |  |
|   |                          |                          |                      | In high-speed, the link starts counting from the end of the receive packet; de-assertion of DIR or an RXCMD indicating RxActive is LOW.   |  |
|   |                          |                          |                      | In full-speed or low-speed, the link starts counting from the RXCMD, indicating LINESTATE has changed from SE0 to J for the receive packet. The timing given ensures inter-packet delays of 2 bit times to 6.5 bit times. |  |
| Receive-Receive (peripheral only)           | 1                        | 1                        | 1                    | Minimum number of clocks between consecutive receive packets. The link must be able to receive both packets.  |  |
| Transmit-Receive (host or peripheral)       | 92                       | 80                       | 718                  | Host or peripheral transmits a packet and will time-out after this amount of clock cycles if a response is not received. Any subsequent transmission can occur after this time.   |  |
|   |                          |                          |                      |   |  |



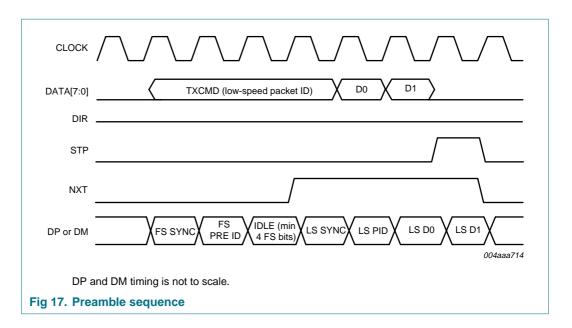
ISP1504A\_ISP1504C\_1 © NXP B.V. 2006. All rights reserved.



## 9.9 Preamble

Preamble packets are headers to low-speed packets that must travel over a full-speed bus, between a host and a hub. To enter preamble mode, the link sets XCVRSELECT[1:0] = 11b in the Function Control register. When in preamble mode, the ISP1504 operates just as in full-speed mode, and sends all data with the full-speed rise and fall times. Whenever the link transmits a USB packet in preamble mode, the ISP1504 will automatically send a preamble header at full-speed bit rate before sending the link packet at low-speed bit rate. The ISP1504 will ensure a minimum gap of four full-speed bit times between the last bit of the full-speed PRE PID and the first bit of the low-speed packet SYNC. The ISP1504 will drive a J for at least one full-speed bit time after sending the PRE PID, after which the pull-up resistor can hold the J state on the bus. An example transmit packet is shown in Figure 17.

In preamble mode, the ISP1504 can also receive low-speed packets from the full-speed bus.



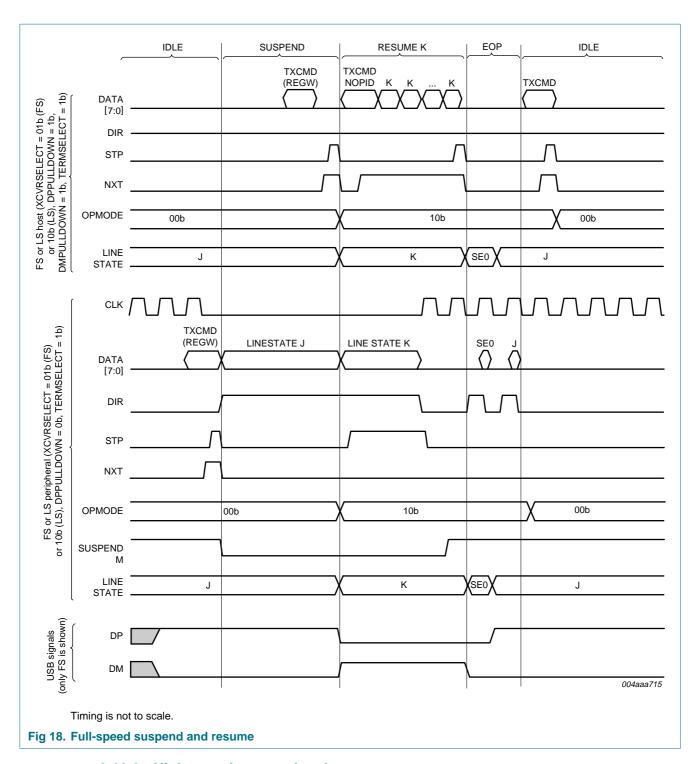
# 9.10 USB suspend and resume

# 9.10.1 Full-speed or low-speed host-initiated suspend and resume

<u>Figure 18</u> illustrates how a host or a hub places a full-speed or low-speed peripheral into suspend and sometime later initiates resume signaling to wake up the downstream peripheral. Note that <u>Figure 18</u> timing is not to scale, and does not show all RXCMD LINESTATE updates.

The sequence of events for a host and a peripheral, both with ISP1504, is as follows:

- 1. Idle: Initially, the host and the peripheral are idle. The host has its 15 k $\Omega$  pull-down resistors enabled (DP\_PULLDOWN and DM\_PULLDOWN are set to 1b) and 45  $\Omega$  terminations disabled (TERMSELECT is set to 1b). The peripheral has the 1.5 k $\Omega$  pull-up resistor connected to DP for full-speed or DM for low-speed (TERMSELECT is set to 1b).
- Suspend: When the peripheral sees no bus activity for 3 ms, it enters the suspend state. The peripheral link places the PHY into low-power mode by setting the SUSPENDM bit in the Function Control register, causing the PHY to draw only suspend current. The host may or may not be powered down.
- 3. Resume K: When the host wants to wake up the peripheral, it sets OPMODE[1:0] to 10b and transmits a K for at least 20 ms. The peripheral link sees the resume K on LINESTATE, and asserts STP to wake up the PHY.
- 4. EOP: When STP is asserted, the ISP1504 on the host side automatically appends an EOP of two bits of SE0 at low-speed bit rate, followed by one bit of J. The ISP1504 on the host side knows to add the EOP because DP\_PULLDOWN and DM\_PULLDOWN are set to 1b for a host. After the EOP is completed, the host link sets OPMODE[1:0] to 00b for normal operation. The peripheral link sees the EOP and also resumes normal operation.



# 9.10.2 High-speed suspend and resume

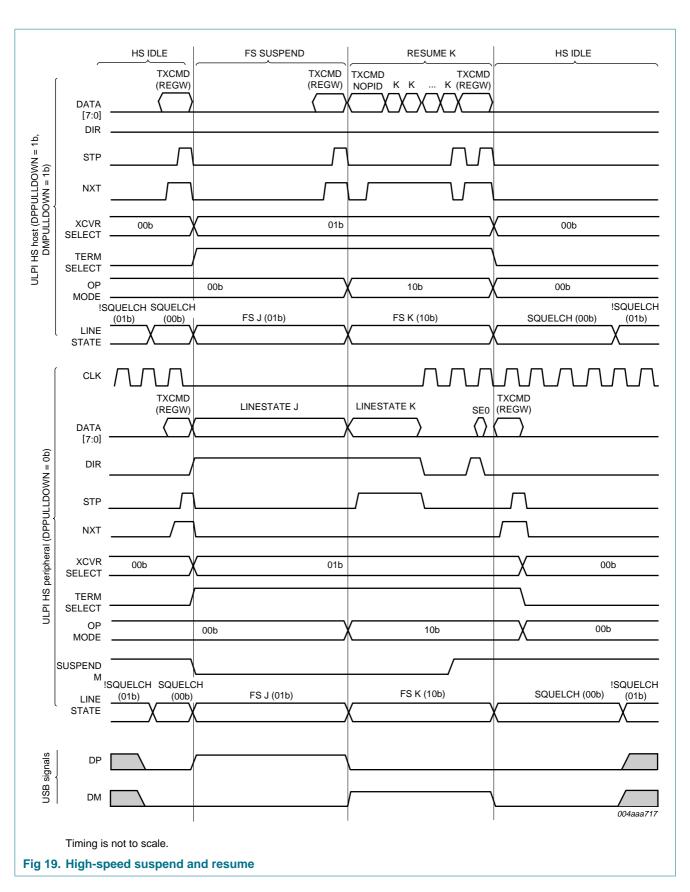
<u>Figure 19</u> illustrates how a host or a hub places a high-speed enabled peripheral into suspend and then initiates resume signaling. The high-speed peripheral will wake up and return to high-speed operations. Note that <u>Figure 19</u> timing is not to scale, and does not show all RXCMD LINESTATE updates.

# ISP1504A; ISP1504C

**ULPI HS USB OTG transceiver** 

The sequence of events related to a host and a peripheral, both with ISP1504, is as follows:

- 1. High-speed idle: Initially, the host and the peripheral are idle. The host has its 15 k $\Omega$  pull-down resistors enabled (DP\_PULLDOWN and DM\_PULLDOWN are set to 1b) and 45  $\Omega$  terminations enabled (TERMSELECT is set to 0b). The peripheral has its 45  $\Omega$  terminations enabled (TERMSELECT is set to 0b).
- 2. Full-speed suspend: When the peripheral sees no bus activity for 3 ms, it enters the suspend state. The peripheral link places the ISP1504 into full-speed mode (XCVRSELECT is set to 01b), removes 45  $\Omega$  terminations, and enables the 1.5 k $\Omega$  pull-up resistor on DP (TERMSELECT is set to 1b). The peripheral link then places the ISP1504 into low-power mode by setting SUSPENDM, causing the ISP1504 to draw only suspend current. The host also changes the ISP1504 to full-speed (XCVRSELECT is set to 01b), removes 45  $\Omega$  terminations (TERMSELECT is set to 1b), and then may or may not be powered down.
- 3. Resume K: When the host wants to wake up the peripheral, it sets OPMODE to 10b and transmits a full-speed K for at least 20 ms. The peripheral link sees the resume K (10b) on LINESTATE, and asserts STP to wake up the ISP1504.
- 4. High-speed traffic: The host link sets high-speed (XCVRSELECT is set to 00b) and enables its 45  $\Omega$  terminations (TERMSELECT is set to 0b). The peripheral link sees SE0 on LINESTATE and also sets high-speed (XCVRSELECT is set to 00b), and enables its 45  $\Omega$  terminations (TERMSELECT is set to 0b). The host link sets OPMODE to 00b for normal high-speed operation.

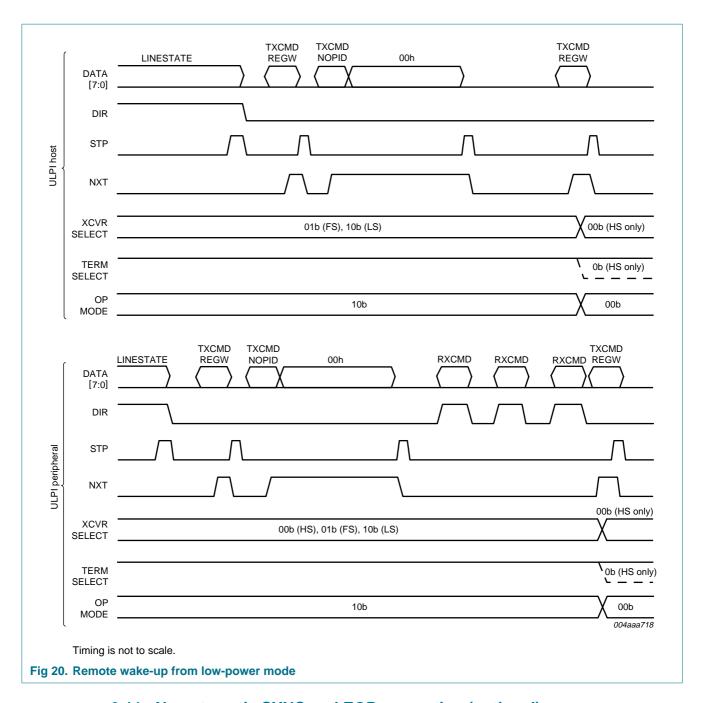


#### 9.10.3 Remote wake-up

The ISP1504 supports peripherals that initiate remote wake-up resume. When placed into USB suspend, the peripheral link remembers at what speed it was originally operating. Depending on the original speed, the link follows one of the protocols detailed here. In Figure 20, timing is not to scale, and not all RXCMD LINESTATE updates are shown.

The sequence of events related to a host and a peripheral, both with ISP1504, is as follows:

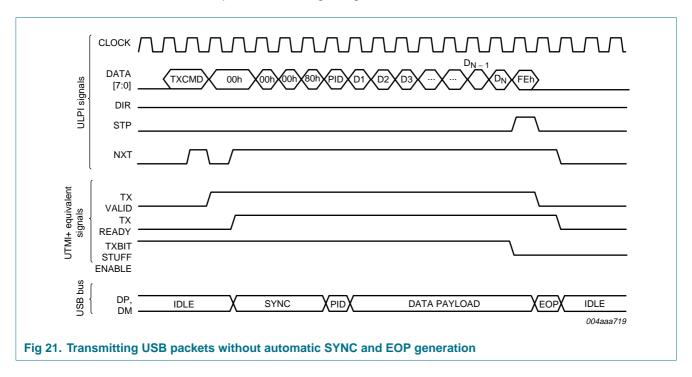
- 1. Both the host and the peripheral are assumed to be in low-power mode.
- 2. The peripheral begins remote wake-up by re-enabling its clock and setting its SUSPENDM bit to 1b.
- 3. The peripheral begins driving K on the bus to signal resume. Note that the peripheral link must assume that LINESTATE is K (01b) while transmitting because it will not receive any RXCMDs.
- 4. The host recognizes the resume, re-enables its clock and sets its SUSPENDM bit.
- 5. The host takes over resume driving within 1 ms of detecting the remote wake-up.
- 6. The peripheral stops driving resume.
- 7. The peripheral sees the host continuing to drive the resume.
- 8. The host stops driving resume and the ISP1504 automatically adds the EOP to the end of the resume. The peripheral recognizes the EOP as the end of resume.
- Both the host and the peripheral revert to normal operation by writing 00b to OPMODE. If the host or the peripheral was previously in high-speed mode, it must revert to high-speed before the SE0 of the EOP is completed. This can be achieved by writing XCVRSELECT = 00b and TERMSELECT = 0b after LINESTATE indicates SE0.



# 9.11 No automatic SYNC and EOP generation (optional)

This setting allows the link to turn off the automatic SYNC and EOP generation, and must be used for high-speed packets only. It is provided for backward compatibility with legacy controllers that include SYNC and EOP bytes in the data payload when transmitting packets. The ISP1504 will not automatically generate the SYNC and EOP patterns when OPMODE[1:0] is set to 11b. The ISP1504 will still NRZI encode data and perform bit stuffing. An example of a sequence is shown in Figure 21. The link must always send packets using the TXCMD (NOPID) type. The ISP1504 does not provide a mechanism to control bit stuffing in individual bytes, but will automatically turn off bit stuffing for EOP when STP is asserted with data set to FEh. If data is set to 00h when STP is asserted, the

PHY will not transmit any EOP. The ISP1504 will also detect if the PID byte is A5h, indicating an SOF packet, and automatically send a long EOP when STP is asserted. To transmit chirp and resume signaling, the link must set OPMODE to 10b.



# 9.12 On-The-Go operations

On-The-Go (OTG) is a supplement to *Universal Serial Bus Specification Rev. 2.0* that allows a portable USB device to assume the role of a limited USB host by defining improvements, such as a small connector and low power. Non-portable devices, such as standard hosts and embedded hosts, can also benefit from OTG features.

The ISP1504 OTG PHY is designed to support all the tasks specified in the OTG supplement. The ISP1504 provides the front-end analog support for Host Negotiation Protocol (HNP) and Session Request Protocol (SRP) for dual-role devices. The supporting components include:

- Built-in 5 V charge pump
- Voltage comparators
  - A\_VBUS\_VLD
  - SESS\_VLD (session valid, can be used for both A-session and B-session valid)
  - SESS\_END (session end)
- Pull-up and pull-down resistors on DP and DM
- ID detector indicates if mini-A or mini-B plug is inserted
- Charge and discharge resistors on V<sub>BUS</sub>

The following subsections describe how to use the ISP1504 OTG components.

## 9.12.1 OTG charge pump

A description of the charge pump is given in Section 7.6.4. When the controller is configured as an A-device, it can provide the  $V_{BUS}$  power by turning on the charge pump. Control of the charge pump is described in Section 9.4.1 and Section 10.1.4.

# 9.12.2 OTG comparators

The ISP1504 provides comparators that conform to *On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2* requirements of  $V_{A\_VBUS\_VLD}$ ,  $V_{A\_SESS\_VLD}$ ,  $V_{B\_SESS\_VLD}$  and  $V_{B\_SESS\_END}$ . In this data sheet,  $V_{A\_SESS\_VLD}$  and  $V_{B\_SESS\_VLD}$  are combined into  $V_{B\_SESS\_VLD}$ . Comparators are described in <u>Section 7.6.2</u>. Changes in comparator values are communicated to the link by RXCMDs as described in <u>Section 9.5.2.2</u>. Control over comparators is described in <u>Section 10.1.8</u>.

# 9.12.3 Pull-up and pull-down resistors

The USB resistors on DP and DM can be used to initiate data-line pulsing SRP. The link must set the required bus state using mode settings in Table 8.

#### 9.12.4 ID detection

The ISP1504 provides an internal pull-up resistor to sense the value of the ID pin. The pull-up resistor must first be enabled by setting the ID\_PULLUP register bit to logic 1. If the value on ID has changed, the ISP1504 will send an RXCMD or interrupt to the link by time  $t_{\text{ID}}$ . If the link does not receive any RXCMD or interrupt by  $t_{\text{ID}}$ , then the ID value has not changed.

# 9.12.5 V<sub>BUS</sub> charge and discharge resistors

A pull-up resistor,  $R_{UP(VBUS)}$ , is provided to perform  $V_{BUS}$  pulsing SRP. A B-device is allowed to charge  $V_{BUS}$  above the session valid threshold to request the host to turn on the  $V_{BUS}$  power.

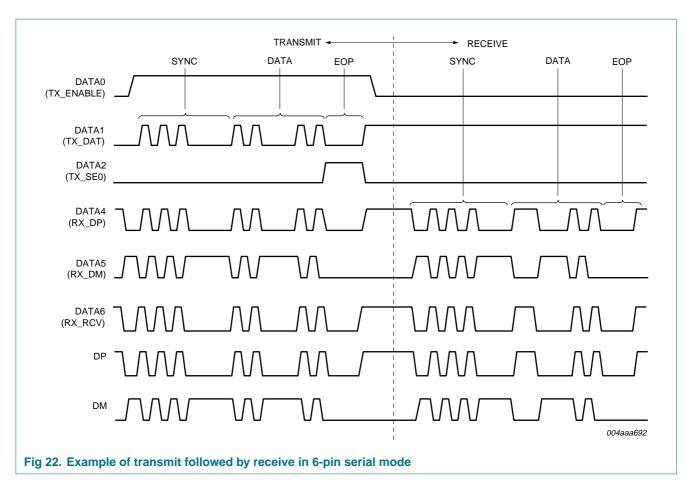
A pull-down resistor,  $R_{DN(VBUS)}$ , is provided for a B-device to discharge  $V_{BUS}$ . This is done whenever the A-device turns off the  $V_{BUS}$  power; the B-device can use the pull-down resistor to ensure  $V_{BUS}$  is below  $V_{BSESSEND}$  before starting a session.

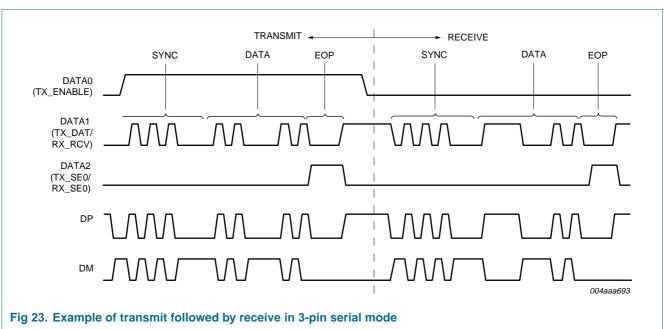
For details, refer to On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2.

#### 9.13 Serial modes

The ISP1504 supports both 6-pin serial mode and 3-pin serial mode, controlled by bits 6PIN\_FSLS\_SERIAL and 3PIN\_FSLS\_SERIAL of the Interface Control register. For details, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*, Section 3.10.

<u>Figure 22</u> and <u>Figure 23</u> provide examples of 6-pin serial mode and 3-pin serial mode, respectively.





# 9.14 Aborting transfers

The ISP1504 supports aborting transfers on the ULPI bus. For details, refer to *UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1*, Section 3.8.4.

# 9.15 Avoiding contention on the ULPI data bus

Because the ULPI data bus is bidirectional, avoid situations in which both the link and the PHY simultaneously drive the data bus.

The following points must be considered while implementing the data bus drive control on the link.

After power-up and clock stabilization, default states are as follows:

- The ISP1504 drives DIR is LOW.
- The data bus is input to the ISP1504.
- The ULPI link data bus is output, with all data bus lines driven to LOW.

When the ISP1504 wants to take control of the data bus to initiate a data transfer, it changes the DIR value from LOW to HIGH.

At this point, the link must disable its output buffers. This needs to be as fast as possible so the link must use a combinational path from DIR.

The ISP1504 will not immediately enable its output buffers, but will delay the enabling of its buffers until the next clock edge, avoiding bus contention.

When the data transfer is no longer required by the ISP1504, it changes DIR from HIGH to LOW and starts to immediately turn off its output drivers. The link senses the change of DIR from HIGH to LOW, but delays enabling its output buffers for one CLOCK cycle, avoiding data bus contention.

# 10. Register map

Table 17. Register map overview

| Field name                                 | Size  | Address (6       | bits)          |     |                            | References                 |  |
|--|-------|------------------|----------------|-----|----------------------------|----------------------------|--|
|  | (bits | R[1]             | W[2] S[3] C[4] |     | C[4]                       |                            |  |
| Immediate register set                     |       | '                | '              | '   | '                          |                            |  |
| Vendor ID Low register                     | 8     | 00h              | -              | -   | -                          | Section 10.1.1 on page 47  |  |
| Vendor ID High register                    | 8     | 01h              | -              | -   | -                          |                            |  |
| Product ID Low register                    | 8     | 02h              | -              | -   | -                          |                            |  |
| Product ID High register                   | 8     | 03h              | -              | -   | -                          |                            |  |
| Function Control register                  | 8     | 04h to 06h       | 04h            | 05h | 06h                        | Section 10.1.2 on page 48  |  |
| Interface Control register                 | 8     | 07h to 09h       | 07h            | 08h | 09h                        | Section 10.1.3 on page 49  |  |
| OTG Control register                       | 8     | 0Ah to 0Ch       | 0Ah            | 0Bh | 0Ch                        | Section 10.1.4 on page 50  |  |
| USB Interrupt Enable Rising Edge register  | 8     | 0Dh to 0Fh       | 0Dh            | 0Eh | 0Fh                        | Section 10.1.5 on page 51  |  |
| USB Interrupt Enable Falling Edge register | 8     | 10h to 12h       | 10h            | 11h | 12h                        | Section 10.1.6 on page 52  |  |
| USB Interrupt Status register              | 8     | 13h              | -              | -   | -                          | Section 10.1.7 on page 52  |  |
| USB Interrupt Latch register               | 8     | 14h              | -              | -   | -                          | Section 10.1.8 on page 53  |  |
| Debug register                             | 8     | 15h              | -              | -   | -                          | Section 10.1.9 on page 54  |  |
| Scratch register                           | 8     | 16h to 18h       | 16h            | 17h | 18h                        | Section 10.1.10 on page 54 |  |
| Reserved (do not use)                      | -     |                  | 19h to         | 2Eh |                            | Section 10.1.11 on page 54 |  |
| Access extended register set               | 8     | -                | 2Fh            | -   | -                          | Section 10.1.12 on page 54 |  |
| Vendor-specific registers                  | 8     |                  | 30h to         | 3Ch |                            | Section 10.1.13 on page 54 |  |
| Power Control register                     | 8     | 3D to 3Fh        |                |     | Section 10.1.14 on page 54 |                            |  |
| Extended register set                      |       | Address (8 bits) |                |     | Section 10.2 on page 55    |                            |  |
| Maps to immediate register set above       | 8     |                  | 00h to         | 3Fh |                            | -                          |  |
| Reserved (do not use)                      | 8     |                  | 40h to         | FFh |                            |                            |  |

<sup>[1]</sup> Read (R): A register can be read. Read-only if this is the only mode given.

# 10.1 Immediate register set

# 10.1.1 Vendor ID and Product ID registers

# 10.1.1.1 Vendor ID Low register

Table 18 shows the bit description of the register.

Table 18. Vendor ID Low register (address R = 00h) bit description

| Bit    | Symbol                 | Access | Value | Description   |
|--------|------------------------|--------|-------|---|
| 7 to 0 | VENDOR_ID_<br>LOW[7:0] | R      | CCh   | <b>Vendor ID Low</b> : Lower byte of the NXP vendor ID supplied by USB-IF; has a fixed value of CCh |

<sup>[2]</sup> Write (W): The pattern on the data bus will be written over all bits of a register.

<sup>[3]</sup> Set (S): The pattern on the data bus is OR-ed with and written to a register.

<sup>[4]</sup> Clear (C): The pattern on the data bus is a mask. If a bit in the mask is set, then the corresponding register bit will be set to zero (cleared).

# 10.1.1.2 Vendor ID High register

The bit description of the register is given in Table 19.

Table 19. Vendor ID High register (address R = 01h) bit description

| Bit    | Symbol                  | Access | Value | Description  |
|--------|-------------------------|--------|-------|--|
| 7 to 0 | VENDOR_ID_<br>HIGH[7:0] | R      | 04h   | <b>Vendor ID High</b> : Upper byte of the NXP vendor ID supplied by USB-IF; has a fixed value of 04h |

# 10.1.1.3 Product ID Low register

The bit description of the Product ID Low register is given in Table 20.

Table 20. Product ID Low register (address R = 02h) bit description

| Bit    | Symbol                  | Access | Value | Description   |
|--------|-------------------------|--------|-------|---|
| 7 to 0 | PRODUCT_ID_<br>LOW[7:0] | R      | 04h   | <b>Product ID Low</b> : Lower byte of the NXP product ID number; has a fixed value of 04h |

# 10.1.1.4 Product ID High register

The bit description of the register is given in Table 21.

Table 21. Product ID High register (address R = 03h) bit description

| Bit    | Symbol                   | Access | Value | Description  |
|--------|--------------------------|--------|-------|--|
| 7 to 0 | PRODUCT_ID_<br>HIGH[7:0] | R      | 15h   | <b>Product ID High</b> : Upper byte of the NXP product ID number; has a fixed value of 15h |

# 10.1.2 Function Control register

This register controls UTMI function settings of the PHY. The bit allocation of the register is given in <u>Table 22</u>.

Table 22. Function Control register (address R = 04h to 06h, W = 04h, S = 05h, C = 06h) bit allocation

| Bit    | 7        | 6        | 5       | 4       | 3       | 2              | 1       | 0         |
|--------|----------|----------|---------|---------|---------|----------------|---------|-----------|
| Symbol | reserved | SUSPENDM | RESET   | ОРМО    | DE[1:0] | TERM<br>SELECT | XCVRSE  | LECT[1:0] |
| Reset  | 0        | 1        | 0       | 0       | 0       | 0              | 0       | 1         |
| Access | R/W/S/C  | R/W/S/C  | R/W/S/C | R/W/S/C | R/W/S/C | R/W/S/C        | R/W/S/C | R/W/S/C   |

Table 23. Function Control register (address R = 04h to 06h, W = 04h, S = 05h, C = 06h) bit description

| Bit    | Symbol      | Description  |
|--------|-------------|--|
| 7      | -           | reserved   |
| 6      | SUSPENDM    | Suspend LOW: Active LOW PHY suspend.   |
|        |             | Places the PHY into low-power mode. The PHY will power down all blocks, except the full-speed receiver, OTG comparators and ULPI interface pins.   |
|        |             | To come out of low-power mode, the link must assert STP. The PHY will automatically clear this bit when it exits low-power mode.   |
|        |             | <b>0b</b> — Low-power mode   |
|        |             | 1b — Powered (default)   |
| 5      | RESET       | Reset: Active HIGH transceiver reset.  |
|        |             | After the link sets this bit, the PHY will assert DIR and reset the digital core. This does not reset the ULPI interface or the ULPI register set.   |
|        |             | When reset is completed, the PHY will de-assert DIR and automatically clear this bit, followed by an RXCMD update to the link.   |
|        |             | <b>0b</b> — Do not reset (default)   |
|        |             | 1b — Reset   |
|        |             | The link must wait for DIR to de-assert before using the ULPI bus. Does not reset the ULPI interface or the ULPI register set.   |
| 4 to 3 | OPMODE[1:0] | Operation Mode: Selects the required bit-encoding style during transmit.   |
|        |             | 00b — Normal operation (default)   |
|        |             | 01b — Non-driving  |
|        |             | 10b — Disable bit-stuffing and NRZI encoding   |
|        |             | <b>11b</b> — Do not automatically add SYNC and EOP when transmitting; must be used only for high-speed packets   |
| 2      | TERMSELECT  | <b>Termination Select</b> : Controls the internal 1.5 k $\Omega$ full-speed pull-up resistor and 45 $\Omega$ high-speed terminations. Control over bus resistors changes, depending on XCVRSELECT[1:0], OPMODE[1:0], DP_PULLDOWN and DM_PULLDOWN, as shown in Table 8. |
| 1 to 0 | XCVRSELECT  | Transceiver Select: Selects the required transceiver speed.  |
|        | [1:0]       | 00b — Enable the high-speed transceiver  |
|        |             | 01b — Enable the full-speed transceiver (default)  |
|        |             | 10b — Enable the low-speed transceiver   |
|        |             | <b>11b</b> — Enable the full-speed transceiver for low-speed packets (full-speed preamble is automatically prefixed)   |

# 10.1.3 Interface Control register

The Interface Control register enables alternative interfaces. All of these modes are optional features provided for legacy link cores. Setting more than one of these fields results in undefined behavior. <u>Table 24</u> provides the bit allocation of the register.

Table 24. Interface Control register (address R = 07h to 09h, W = 07h, S = 08h, C = 09h) bit allocation

|        |                   | •                |               | •        | •                  | •        |                          |                          |
|--------|-------------------|------------------|---------------|----------|--------------------|----------|--------------------------|--------------------------|
| Bit    | 7                 | 6                | 5             | 4        | 3                  | 2        | 1                        | 0                        |
| Symbol | INTF_<br>PROT_DIS | IND_PASS<br>THRU | IND_<br>COMPL | reserved | CLOCK_<br>SUSPENDM | reserved | 3PIN_<br>FSLS_<br>SERIAL | 6PIN_<br>FSLS_<br>SERIAL |
| Reset  | 0                 | 0                | 0             | 0        | 0                  | 0        | 0                        | 0                        |
| Access | R/W/S/C           | R/W/S/C          | R/W/S/C       | R/W/S/C  | R/W/S/C            | R/W/S/C  | R/W/S/C                  | R/W/S/C                  |

Table 25. Interface Control register (address R = 07h to 09h, W = 07h, S = 08h, C = 09h) bit description

| Table | 25. Interrace Control i | register (address R = 07n to 09n, W = 07n, S = 08n, C = 09n) bit description  |
|-------|-------------------------|---|
| Bit   | Symbol                  | Description   |
| 7     | INTF_PROT_DIS           | Interface Protect Disable: Controls circuitry built into the ISP1504 to protect the ULPI interface when the link 3-states STP and DATA[7:0]. When this bit is enabled, the ISP1504 will automatically detect when the link stops driving STP. |
|       |                         | <b>0b</b> — Enables the interface protect circuit (default). The ISP1504 attaches a weak pull-up resistor on STP. If STP is unexpectedly HIGH, the ISP1504 attaches weak pull-down resistors on DATA[7:0], protecting data inputs.            |
|       |                         | <b>1b</b> — Disables the interface protect circuit, detaches weak pull-down resistors on DATA[7:0], and a weak pull-up resistor on STP.   |
| 6     | IND_PASSTHRU            | <b>Indicator Pass-through</b> : Controls whether the complement output is qualified with the internal A_VBUS_VLD comparator before being used in the V <sub>BUS</sub> state in RXCMD. For details, see Section 9.5.2.2.                       |
|       |                         | <b>0b</b> — The complement output signal is qualified with the internal A_VBUS_VLD comparator (default).  |
|       |                         | <b>1b</b> — The complement output signal is not qualified with the internal A_VBUS_VLD comparator.  |
| 5     | IND_COMPL               | <b>Indicator Complement</b> : Informs the PHY to invert the FAULT input signal, generating the complement output. For details, see Section 9.5.2.2.   |
|       |                         | <b>0b</b> — The ISP1504 will not invert the FAULT signal (default).   |
|       |                         | <b>1b</b> — The ISP1504 will invert the FAULT signal.   |
| 4     | -                       | reserved  |
| 3     | CLOCK_SUSPENDM          | Clock Suspend LOW: Active LOW clock suspend.  |
|       |                         | Powers down the internal clock circuitry only. By default, the clock will not be powered in 6-pin serial mode or 3-pin serial mode.   |
|       |                         | Valid only in 6-pin serial mode and 3-pin serial mode. Valid only when SUSPENDM is set to logic 1, otherwise this bit is ignored.   |
|       |                         | <b>0b</b> — Clock will not be powered in 3-pin or 6-pin serial mode (default).  |
|       |                         | 1b — Clock will be powered in 3-pin and 6-pin serial mode.  |
| 2     | -                       | reserved  |
| 1     | 3PIN_FSLS_SERIAL        | <b>3-Pin Full-Speed Low-Speed Serial Mode</b> : Changes the ULPI interface to a 3-bit serial interface. The PHY will automatically clear this bit when 3-pin serial mode is exited.   |
|       |                         | <b>0b</b> — Full-speed or low-speed packets are sent using the parallel interface (default).  |
|       |                         | <b>1b</b> — Full-speed or low-speed packets are sent using the 3-pin serial interface.  |
| 0     | 6PIN_FSLS_SERIAL        | <b>6-Pin Full-Speed Low-Speed Serial Mode</b> : Changes the ULPI interface to a 6-bit serial interface. The PHY will automatically clear this bit when 6-pin serial mode is exited.   |
|       |                         | <b>0b</b> — Full-speed or low-speed packets are sent using the parallel interface (default).  |
|       |                         | <b>1b</b> — Full-speed or low-speed packets are sent using the 6-pin serial interface.  |
|       |                         |   |

# 10.1.4 OTG Control register

This register controls various OTG functions of the ISP1504. The bit allocation of the OTG Control register is given in Table 26.

Table 26. OTG Control register (address R = 0Ah to 0Ch, W = 0Ah, S = 0Bh, C = 0Ch) bit allocation

| Bit    | 7                    | 6                | 5            | 4             | 3                | 2               | 1               | 0             |
|--------|----------------------|------------------|--------------|---------------|------------------|-----------------|-----------------|---------------|
| Symbol | USE_EXT_<br>VBUS_IND | DRV_<br>VBUS_EXT | DRV_<br>VBUS | CHRG_<br>VBUS | DISCHRG_<br>VBUS | DM_PULL<br>DOWN | DP_PULL<br>DOWN | ID_PULL<br>UP |
| Reset  | 0                    | 0                | 0            | 0             | 0                | 1               | 1               | 0             |
| Access | R/W/S/C              | R/W/S/C          | R/W/S/C      | R/W/S/C       | R/W/S/C          | R/W/S/C         | R/W/S/C         | R/W/S/C       |

Table 27. OTG Control register (address R = 0Ah to 0Ch, W = 0Ah, S = 0Bh, C = 0Ch) bit description

|     |              | system (address it = thin to ton, tt = thin, to = ton, to = ton) bit description  |
|-----|--------------|---|
| Bit | Symbol       | Description   |
| 7   |              | $\textbf{Use External $V_{BUS}$ Indicator: Informs the PHY to use an external $V_{BUS}$ overcurrent indicator.}$  |
|     | IND          | <b>0b</b> — Use the internal OTG comparator (default).  |
|     |              | ${f 1b}$ — Use the external $V_{BUS}$ valid indicator signal input from the FAULT pin.  |
| 6   | DRV_VBUS_EXT | <b>Drive V<sub>BUS</sub> External</b> : Selects between the internal and external 5 V V <sub>BUS</sub> supply. Using an external charge pump or a 5 V supply is optional.   |
|     |              | <b>0b</b> — Drive V <sub>BUS</sub> using the internal charge pump. Also ensures PSW_N is not driven to LOW (default).   |
|     |              | <b>1b</b> — Drive V <sub>BUS</sub> using the external charge pump or the 5 V supply. Drives PSW_N to LOW.   |
| 5   | DRV_VBUS     | <b>Drive <math>V_{BUS}</math></b> : Signals the ISP1504 to drive 5 V on $V_{BUS}$ . If DRV_VBUS_EXT is set to logic 1, then setting DRV_VBUS is optional.   |
|     |              | <b>0b</b> — Do not drive V <sub>BUS</sub> (default).  |
|     |              | <b>1b</b> — Drive 5 V on V <sub>BUS</sub> .   |
| 4   | CHRG_VBUS    | <b>Charge V</b> <sub>BUS</sub> : Charges V <sub>BUS</sub> through a resistor. Used for the V <sub>BUS</sub> pulsing SRP. The link must first check that V <sub>BUS</sub> is discharged (see bit DISCHRG_VBUS), and that both the DP and DM data lines have been LOW (SE0) for 2 ms. |
|     |              | <b>0b</b> — Do not charge V <sub>BUS</sub> (default).   |
|     |              | <b>1b</b> — Charge V <sub>BUS</sub> .   |
| 3   | DISCHRG_VBUS | <b>Discharge V<sub>BUS</sub></b> : Discharges V <sub>BUS</sub> through a resistor. If the link sets this bit to logic 1, it waits for an RXCMD indicating that SESS_END has changed from 0 to 1, and then resets this bit to 0 to stop the discharge.                               |
|     |              | <b>0b</b> — Do not discharge V <sub>BUS</sub> (default).  |
|     |              | <b>1b</b> — Discharge V <sub>BUS</sub> .  |
| 2   | DM_PULLDOWN  | <b>DM Pull Down</b> : Enables the 15 k $\Omega$ pull-down resistor on DM.   |
|     |              | <b>0b</b> — Pull-down resistor is not connected to DM.  |
|     |              | 1b — Pull-down resistor is connected to DM (default).   |
| 1   | DP_PULLDOWN  | <b>DP Pull Down</b> : Enables the 15 k $\Omega$ pull-down resistor on DP.   |
|     |              | <b>0b</b> — Pull-down resistor is not connected to DP.  |
|     |              | 1b — Pull-down resistor is connected to DP (default).   |
| 0   | ID_PULLUP    | <b>ID Pull Up</b> : Connects a pull-up to the ID line and enables sampling of the ID level. Disabling the ID line sampler will reduce PHY power consumption.  |
|     |              | <b>0b</b> — Disables sampling of the ID line (default).   |
|     |              | 1b — Enables sampling of the ID line.   |

# 10.1.5 USB Interrupt Enable Rising Edge register

The bits in this register enable interrupts and RXCMDs to be sent when the corresponding bits in the USB Interrupt Status register change from logic 0 to logic 1. By default, all transitions are enabled. Table 28 shows the bit allocation of the register.

Table 28. USB Interrupt Enable Rising Edge register (address R = 0Dh to 0Fh, W = 0Dh, S = 0Eh, C = 0Fh) bit allocation

| Bit    | 7       | 6        | 5       | 4        | 3              | 2                | 1                | 0                 |
|--------|---------|----------|---------|----------|----------------|------------------|------------------|-------------------|
| Symbol |         | reserved |         | ID_GND_R | SESS_<br>END_R | SESS_<br>VALID_R | VBUS_<br>VALID_R | HOST_<br>DISCON_R |
| Reset  | 0       | 0        | 0       | 1        | 1              | 1                | 1                | 1                 |
| Access | R/W/S/C | R/W/S/C  | R/W/S/C | R/W/S/C  | R/W/S/C        | R/W/S/C          | R/W/S/C          | R/W/S/C           |

© NXP B.V. 2006. All rights reserved.

Table 29. USB Interrupt Enable Rising Edge register (address R = 0Dh to 0Fh, W = 0Dh, S = 0Eh, C = 0Fh) bit description

| Bit    | Symbol            | Description   |
|--------|-------------------|---|
| 7 to 5 | -                 | reserved  |
| 4      | ID_GND_R          | <b>ID Ground Rise</b> : Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on ID_GND.                         |
| 3      | SESS_END_R        | <b>Session End Rise</b> : Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on SESS_END.                     |
| 2      | SESS_VALID_R      | <b>Session Valid Rise</b> : Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on SESS_VLD.                   |
| 1      | VBUS_VALID_R      | <b>V</b> <sub>BUS</sub> <b>Valid Rise</b> : Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on A_VBUS_VLD. |
| 0      | HOST_DISCON_<br>R | <b>Host Disconnect Rise</b> : Enables interrupts and RXCMDs for logic 0 to logic 1 transitions on HOST_DISCON.              |

# 10.1.6 USB Interrupt Enable Falling Edge register

The bits in this register enable interrupts and RXCMDs to be sent when the corresponding bits in the USB Interrupt Status register change from logic 1 to logic 0. By default, all transitions are enabled. See Table 30.

Table 30. USB Interrupt Enable Falling Edge register (address R = 10h to 12h, W = 10h, S = 11h, C = 12h) bit allocation

| Bit    | 7        | 6       | 5       | 4        | 3              | 2                | 1                | 0                 |
|--------|----------|---------|---------|----------|----------------|------------------|------------------|-------------------|
| Symbol | reserved |         |         | ID_GND_F | SESS_<br>END_F | SESS_<br>VALID_F | VBUS_<br>VALID_F | HOST_<br>DISCON_F |
| Reset  | 0        | 0       | 0       | 1        | 1              | 1                | 1                | 1                 |
| Access | R/W/S/C  | R/W/S/C | R/W/S/C | R/W/S/C  | R/W/S/C        | R/W/S/C          | R/W/S/C          | R/W/S/C           |

Table 31. USB Interrupt Enable Falling Edge register (address R = 10h to 12h, W = 10h, S = 11h, C = 12h) bit description

| Bit    | Symbol        | Description   |
|--------|---------------|---|
| 7 to 5 | -             | reserved  |
| 4      | ID_GND_F      | <b>ID Ground Fall</b> : Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on ID_GND.                 |
| 3      | SESS_END_F    | <b>Session End Fall</b> : Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on SESS_END.             |
| 2      | SESS_VALID_F  | <b>Session Valid Fall</b> : Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on SESS_VLD.           |
| 1      | VBUS_VALID_F  | <b>V<sub>BUS</sub> Valid Fall</b> : Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on A_VBUS_VLD. |
| 0      | HOST_DISCON_F | <b>Host Disconnect Fall</b> : Enables interrupts and RXCMDs for logic 1 to logic 0 transitions on HOST_DISCON.      |

# 10.1.7 USB Interrupt Status register

This register (see Table 32) indicates the current value of the interrupt source signal.

Table 32. USB Interrupt Status register (address R = 13h) bit allocation

| Bit    | 7        | 6 | 5 | 4      | 3            | 2              | 1              | 0               |
|--------|----------|---|---|--------|--------------|----------------|----------------|-----------------|
| Symbol | reserved |   |   | ID_GND | SESS_<br>END | SESS_<br>VALID | VBUS_<br>VALID | HOST_<br>DISCON |
| Reset  | Х        | X | Χ | 0      | 0            | 0              | 0              | 0               |
| Access | R        | R | R | R      | R            | R              | R              | R               |

Table 33. USB Interrupt Status register (address R = 13h) bit description

| Bit    | Symbol      | Description  |
|--------|-------------|--|
| 7 to 5 | -           | reserved   |
| 4      | ID_GND      | ID Ground: Reflects the current value of the ID detector circuit.                                    |
| 3      | SESS_END    | Session End: Reflects the current value of the session end voltage comparator.                       |
| 2      | SESS_VALID  | Session Valid: Reflects the current value of the session valid voltage comparator.                   |
| 1      | VBUS_VALID  | V <sub>BUS</sub> Valid: Reflects the current value of the V <sub>BUS</sub> valid voltage comparator. |
| 0      | HOST_DISCON | Host Disconnect: Reflects the current value of the host disconnect detector.                         |

# 10.1.8 USB Interrupt Latch register

The bits of the USB Interrupt Latch register are automatically set by the ISP1504 when an unmasked change occurs on the corresponding interrupt source signal. The ISP1504 will automatically clear all bits when the link reads this register, or when the PHY enters low-power mode.

**Remark:** It is optional for the link to read this register when the clock is running because all signal information will automatically be sent to the link through the RXCMD byte.

The bit allocation of this register is given in <a>Table 34</a>.

Table 34. USB Interrupt Latch register (address R = 14h) bit allocation

| Bit    | 7        | 6 | 5 | 4        | 3              | 2                | 1                | 0                 |
|--------|----------|---|---|----------|----------------|------------------|------------------|-------------------|
| Symbol | reserved |   |   | ID_GND_L | SESS_<br>END_L | SESS_<br>VALID_L | VBUS_<br>VALID_L | HOST_<br>DISCON_L |
| Reset  | 0        | 0 | 0 | 0        | 0              | 0                | 0                | 0                 |
| Access | R        | R | R | R        | R              | R                | R                | R                 |

Table 35. USB Interrupt Latch register (address R = 14h) bit description

| Bit    | Symbol        | Description   |
|--------|---------------|---|
| 7 to 5 | -             | reserved  |
| 4      | ID_GND_L      | <b>ID Ground Latch</b> : Automatically set when an unmasked event occurs on ID_GND. Cleared when this register is read.                 |
| 3      | SESS_END_L    | <b>Session End Latch</b> : Automatically set when an unmasked event occurs on SESS_END. Cleared when this register is read.             |
| 2      | SESS_VALID_L  | <b>Session Valid Latch</b> : Automatically set when an unmasked event occurs on SESS_VLD. Cleared when this register is read.           |
| 1      | VBUS_VALID_L  | <b>V<sub>BUS</sub> Valid Latch</b> : Automatically set when an unmasked event occurs on A_VBUS_VLD. Cleared when this register is read. |
| 0      | HOST_DISCON_L | <b>Host Disconnect Latch</b> : Automatically set when an unmasked event occurs on HOST_DISCON. Cleared when this register is read.      |

# 10.1.9 Debug register

The bit allocation of the Debug register is given in <u>Table 36</u>. This register indicates the current value of signals useful for debugging.

Table 36. Debug register (address R = 15h) bit allocation

| Bit    | 7 | 6 | 5    | 4     | 3 | 2 | 1              | 0              |
|--------|---|---|------|-------|---|---|----------------|----------------|
| Symbol |   |   | rese | erved |   |   | LINE<br>STATE1 | LINE<br>STATE0 |
| Reset  | 0 | 0 | 0    | 0     | 0 | 0 | 0              | 0              |
| Access | R | R | R    | R     | R | R | R              | R              |

Table 37. Debug register (address R = 15h) bit description

| Bit    | Symbol     | Description  |
|--------|------------|--|
| 7 to 2 | -          | reserved   |
| 1      | LINESTATE1 | Line State 1: Contains the current value of LINESTATE 1. |
| 0      | LINESTATE0 | Line State 0: Contains the current value of LINESTATE 0. |

# 10.1.10 Scratch register

This is an empty register for testing purposes; see Table 38.

Table 38. Scratch register (address R = 16h to 18h, W = 16h, S = 17h, C = 18h) bit description

| Bit    | Symbol       | Access  | Value | Description   |
|--------|--------------|---------|-------|---|
| 7 to 0 | SCRATCH[7:0] | R/W/S/C | 00h   | <b>Scratch</b> : This is an empty register byte for testing purposes. Software can read, write, set and clear this register; and the functionality of the PHY will not be affected. |

#### 10.1.11 Reserved

Registers 19h to 2Eh are not implemented. Operating on these addresses will have no effect on the PHY.

## 10.1.12 Access extended register set

Address 2Fh does not contain register data. Instead it links to the extended register set. The immediate register set maps to the lower end of the extended register set.

#### 10.1.13 Vendor-specific registers

Addresses 30h to 3Fh contains vendor-specific registers.

# 10.1.14 Power Control register

This register controls various aspects of the ISP1504. <u>Table 39</u> shows the bit allocation of the register.

Table 39. Power Control register (address R = 3Dh to 3Fh, W = 3Dh, S = 3Eh, C = 3Fh) bit allocation

| Bit    | 7        | 6       | 5       | 4       | 3               | 2               | 1       | 0       |
|--------|----------|---------|---------|---------|-----------------|-----------------|---------|---------|
| Symbol | reserved |         |         |         | BVALID_<br>FALL | BVALID_<br>RISE | rese    | rved    |
| Reset  | 0        | 0       | 0       | 0       | 0               | 0               | 0       | 0       |
| Access | R/W/S/C  | R/W/S/C | R/W/S/C | R/W/S/C | R/W/S/C         | R/W/S/C         | R/W/S/C | R/W/S/C |

Table 40. Power Control register (address R = 3Dh to 3Fh, W = 3Dh, S = 3Eh, C = 3Fh) bit description

| Bit    | Symbol      | Description  |
|--------|-------------|--|
| 7 to 4 | -           | reserved; the link must never write logic 1 to these bits.   |
| 3      | BVALID_FALL | <b>BValid Fall</b> : Enables RXCMDs for HIGH-to-LOW transitions on BVALID. When BVALID changes from HIGH to LOW, the ISP1504 will send an RXCMD to the link with the ALT_INT bit set to logic 1. |
|        |             | This bit is optional and is not necessary for OTG devices. The session valid comparator should be used instead.  |
| 2      | BVALID_RISE | <b>BValid Rise</b> : Enables RXCMDs for LOW-to-HIGH transitions on BVALID. When BVALID changes from LOW to HIGH, the ISP1504 will send an RXCMD to the link with the ALT_INT bit set to logic 1. |
|        |             | This bit is optional and is not necessary for OTG devices. The session valid comparator should be used instead.  |
| 1 to 0 | -           | reserved; the link must never write logic 1 to this bit.   |

# 10.2 Extended register set

Addresses 00h to 3Fh of the extended register set directly map to the immediate set. This means a read, write, set or clear operation to these extended addresses will operate on the immediate register set.

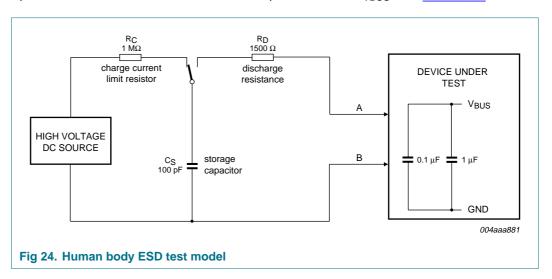
Addresses 40h to FFh are not implemented. Operating on these addresses will have no effect on the PHY.

# 11. ElectroStatic Discharge (ESD)

# 11.1 ESD protection

The pins that are connected to the USB connector (DP, DM, ID,  $V_{BUS}$  and GND) have a minimum of  $\pm 4$  kV ESD protection. Capacitors 0.1  $\mu$ F and 1  $\mu$ F must be connected in parallel from  $V_{BUS}$  to GND to achieve this  $\pm 4$  kV ESD protection (see Figure 24).

**Remark:** Capacitors 0.1  $\mu$ F and 1  $\mu$ F are also required by *Universal Serial Bus Specification Rev. 2.0.* For details on the requirements for C<sub>VBUS</sub>, see Section 16.



# 11.2 ESD test conditions

A detailed report on test setup and results is available on request.

# 12. Limiting values

Table 41. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol               | Parameter                       | Conditions  | Min             | Max                   | Unit |
|----------------------|---------------------------------|---|-----------------|-----------------------|------|
| $V_{CC}$             | supply voltage                  |   | -0.5            | +4.6                  | V    |
| V <sub>CC(I/O)</sub> | input/output supply voltage     |   | -0.5            | +4.6                  | V    |
| VI                   | input voltage                   | on pins CLOCK, STP, DATA[7:0], RESET_N and CHIP_SELECT_N  | -0.5            | $V_{CC(I/O)} + 0.5 V$ | V    |
|                      |                                 | on pins $V_{\mbox{\scriptsize BUS}},$ FAULT and PSW_N     | -0.5            | +6.0                  | V    |
|                      |                                 | on pin XTAL1  | -0.5            | +2.5                  | V    |
|                      |                                 | on pin ID   | -0.5            | +4.6                  | V    |
| V <sub>ESD</sub>     | electrostatic discharge voltage | pins DP, DM, ID, $V_{BUS}$ and GND; $I_{LI} < 1 \; \mu A$ | <u>[1]</u> –4   | +4                    | kV   |
|                      |                                 | all other pins; $I_{LI}$ < 1 $\mu$ A                      | <u>[1]</u> –1.5 | +1.5                  | kV   |
| I <sub>lu</sub>      | latch-up current                | $-0.5 \times V_{CC} < V < +1.5 \times V_{CC}$             | -               | 100                   | mA   |
| T <sub>stg</sub>     | storage temperature             |   | -40             | +125                  | °C   |
| Tj                   | junction temperature            |   | -40             | +125                  | °C   |
|                      |                                 |   |                 |                       |      |

<sup>[1]</sup> Equivalent to discharging a 100 pF capacitor through a 1.5 k $\Omega$  resistor (Human Body Model JESD22-A114D).

# 13. Recommended operating conditions

Table 42. Recommended operating conditions

| Symbol               | Parameter                   | Conditions   |     | Min  | Тур | Max                  | Unit |
|----------------------|-----------------------------|--|-----|------|-----|----------------------|------|
| $V_{CC}$             | supply voltage              |  |     | 3.0  | 3.3 | 3.6                  | V    |
| V <sub>CC(I/O)</sub> | input/output supply voltage |  | [1] | 1.65 | -   | 3.6                  | V    |
| VI                   | input voltage               | on pins CLOCK, STP, DATA[7:0], RESET_N and CHIP_SELECT_N |     | 0    | -   | V <sub>CC(I/O)</sub> | V    |
|                      |                             | on pins $V_{BUS}$ , FAULT and PSW_N                      |     | 0    | -   | 5.5                  | V    |
|                      |                             | on pins DP, DM and ID                                    |     | 0    | -   | 3.6                  | V    |
|                      |                             | on pin XTAL1   |     | 0    | -   | 1.95                 | V    |
| T <sub>amb</sub>     | ambient temperature         |  |     | -40  | +25 | +85                  | °C   |

<sup>[1]</sup>  $V_{CC(I/O)}$  should be less than or equal to  $V_{CC}$ .

# 14. Static characteristics

#### Table 43. Static characteristics: supply pins

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol                 | Parameter                                  | Conditions  | Min   | Тур | Max  | Unit |
|------------------------|--|---|-------|-----|------|------|
| V <sub>(REG3V3)</sub>  | voltage on pin REG3V3                      |   | 3.0   | 3.3 | 3.6  | V    |
| V <sub>(REG1V8)</sub>  | voltage on pin REG1V8                      |   | 1.65  | 1.8 | 1.95 | V    |
| V <sub>POR(trip)</sub> | power-on reset trip voltage                |   | 1.0   | -   | 1.5  | V    |
| I <sub>CC</sub>        | supply current                             | charge pump disabled  |       |     |      |      |
|                        |  | low-power mode; $V_{BUS}$ valid detector disabled; 1.5 k $\Omega$ pull-up resistor on pin DP disconnected | -     | 35  | 85   | μΑ   |
|                        |  | low-power mode; $V_{BUS}$ valid detector disabled; 1.5 k $\Omega$ pull-up resistor on pin DP connected    | -     | 215 | 280  | μΑ   |
|                        |  | full-speed idle; no USB activity  | -     | 10  | -    | mA   |
|                        |  | high-speed idle; no USB activity  | -     | 19  | -    | mΑ   |
|                        |  | full-speed continuous data transmit,<br>50 pF load on pins DP and DM                                      | [1] - | 15  | -    | mA   |
|                        |  | full-speed continuous data receive  | [1] - | 11  | -    | mA   |
|                        |  | high-speed continuous data transmit, 45 $\Omega$ load on pins DP and DM to ground                         | [1] - | 48  | -    | mA   |
|                        |  | high-speed continuous data receive  | [1] - | 28  | -    | mA   |
|                        |  | charge pump enabled   |       |     |      |      |
|                        |  | I <sub>O(VBUS)</sub> = 8 mA; charge pump supply current only  | -     | 20  | 23   | mA   |
|                        |  | I <sub>O(VBUS)</sub> = 0 mA; charge pump supply current only  | -     | 300 | -    | μΑ   |
| I <sub>CC(I/O)</sub>   | supply current on pin V <sub>CC(I/O)</sub> | ULPI interface pins are static  | -     | -   | 1    | μΑ   |

<sup>[1]</sup> A continuous stream of 1 kB packets with minimum inter-packet gap and all data bits set to logic 0 for continuous toggling.

Table 44. Static characteristics: digital pins (CLOCK, DIR, STP, NXT, DATA[7:0], RESET\_N, CHIP\_SELECT\_N)

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol          | Parameter                 | Conditions               | Min                      | Тур  | Max                             | Unit |
|-----------------|---------------------------|--------------------------|--------------------------|------|---------------------------------|------|
| Input leve      | els                       |                          |                          |      |                                 |      |
| V <sub>IL</sub> | LOW-level input voltage   |                          | -                        | -    | $0.3 \times V_{\text{CC(I/O)}}$ | V    |
| V <sub>IH</sub> | HIGH-level input voltage  |                          | $0.7 \times V_{CC(I/O)}$ | -    | -                               | V    |
| I <sub>IL</sub> | LOW-level input current   | $V_I = 0 V$              | -                        | -    | 1                               | μΑ   |
| I <sub>IH</sub> | HIGH-level input current  | $V_I = V_{CC(I/O)}$      | -                        | -    | 1                               | μΑ   |
| ILI             | input leakage current     |                          | <b>–1</b>                | +0.1 | +1                              | μΑ   |
| Output le       | vels                      |                          |                          |      |                                 |      |
| $V_{OL}$        | LOW-level output voltage  | $I_{OL} = -2 \text{ mA}$ | -                        | -    | 0.4                             | V    |
| $V_{OH}$        | HIGH-level output voltage | $I_{OH}$ = +2 mA         | $V_{CC(I/O)} - 0.4 V$    | -    | -                               | V    |

Table 44. Static characteristics: digital pins (CLOCK, DIR, STP, NXT, DATA[7:0], RESET\_N, CHIP\_SELECT\_N) ...continued

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol          | Parameter                 | Conditions  | Min  | Тур        | Max | Unit |
|-----------------|---------------------------|---|------|------------|-----|------|
| I <sub>OH</sub> | HIGH-level output current | $V_{O} = V_{CC(I/O)} - 0.4 \text{ V}$                                     | -4.8 | -          | -   | mA   |
| I <sub>OL</sub> | LOW-level output current  | $V_0 = 0.4 \text{ V}$   | 4.2  | -          | -   | mA   |
| l <sub>OZ</sub> | off-state output current  | $0 V < V_O < V_{CC(I/O)}$   | -    | -          | 1   | μΑ   |
| Impedance       |                           |   |      |            |     |      |
| $Z_{L}$         | load impedance            |   | 45   | -          | 65  | Ω    |
| Pull-up a       | nd pull-down              |   |      |            |     |      |
| I <sub>pd</sub> | pull-down current         | interface protect enabled;<br>DATA[7:0] pins only;<br>$V_I = V_{CC(I/O)}$ | 25   | 50         | 90  | μΑ   |
| $I_{pu}$        | pull-up current           | interface protect enabled;<br>STP pin only; $V_I = 0 V$                   | -30  | <b>–50</b> | -80 | μΑ   |
| Capacita        | nce                       |   |      |            |     |      |
| C <sub>in</sub> | input capacitance         | pins STP, RESET_N,<br>CLOCK, DATA[7:0],<br>CHIP_SELECT_N                  | -    | -          | 3.5 | pF   |

# Table 45. Static characteristics: digital pin FAULT

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol          | Parameter                | Conditions          | Min | Тур | Max | Unit |
|-----------------|--------------------------|---------------------|-----|-----|-----|------|
| Input levels    |                          |                     |     |     |     |      |
| $V_{IL}$        | LOW-level input voltage  |                     | -   | -   | 0.8 | V    |
| $V_{IH}$        | HIGH-level input voltage |                     | 2.0 | -   | -   | V    |
| I <sub>IL</sub> | LOW-level input current  | $V_I = 0 V$         | -   | -   | 1   | μΑ   |
| I <sub>IH</sub> | HIGH-level input current | $V_I = V_{CC(I/O)}$ | -   | -   | 1   | μΑ   |

# Table 46. Static characteristics: digital pin PSW\_N

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Output levels  V <sub>OH</sub> HIGH-level output voltage external pull-up resistor 5.5 | V  |
|--|----|
| V <sub>OH</sub> HIGH-level output voltage external pull-up resistor 5.5                | 17 |
| connected  | V  |
| $V_{OL}$ LOW-level output voltage $I_{OL} = -4 \text{ mA}$ - 0.4                       | V  |
| I <sub>OH</sub> HIGH-level output current external pull-up resistor 1 connected        | μΑ |
| $I_{OL}$ LOW-level output current $V_O = 0.4 \text{ V}$ 4.0 -                          | mA |

Table 47. Static characteristics: analog I/O pins (DP, DM)

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol              | Parameter   | Conditions  | Min  | Тур  | Max  | Unit |
|---------------------|---|---|------|------|------|------|
| Original U          | SB transceiver (low-speed and full-spe  | eed)  |      |      |      |      |
| Input levels        | (differential receiver)   |   |      |      |      |      |
| $V_{DI}$            | differential input sensitivity  | $ V_{DP} - V_{DM} $   | 0.2  | -    | -    | V    |
| $V_{CM}$            | differential common mode voltage range  | includes V <sub>DI</sub> range  | 0.8  | -    | 2.5  | V    |
| Input levels        | (single-ended receivers)  |   |      |      |      |      |
| V <sub>IL</sub>     | LOW-level input voltage   |   | -    | -    | 0.8  | V    |
| V <sub>IH</sub>     | HIGH-level input voltage  |   | 2.0  | -    | -    | V    |
| Output leve         | ıls   |   |      |      |      |      |
| V <sub>OL</sub>     | LOW-level output voltage  | pull-up on pin DP;<br>$R_L = 1.5 \text{ k}\Omega \text{ to } 3.6 \text{ V}$ | 0.0  | 0.18 | 0.3  | V    |
| V <sub>OH</sub>     | HIGH-level output voltage   | pull-down on pins DP and DM; $R_L = 15 \text{ k}\Omega$ to GND              | 2.8  | 3.2  | 3.6  | V    |
| Termination         | 1   |   |      |      |      |      |
| $V_{TERM}$          | termination voltage   | for 1.5 k $\Omega$ pull-up resistor   | 3.0  | -    | 3.6  | V    |
| Resistance          |   |   |      |      |      |      |
| R <sub>UP(DP)</sub> | pull-up resistance on pin DP  |   | 1425 | 1500 | 1575 | Ω    |
| High-spee           | d USB transceiver   |   |      |      |      |      |
| Input levels        | (differential receiver)   |   |      |      |      |      |
| V <sub>HSSQ</sub>   | high-speed squelch detection<br>threshold voltage (differential signal<br>amplitude)    |   | 100  | -    | 150  | mV   |
| V <sub>HSDSC</sub>  | high-speed disconnect detection<br>threshold voltage (differential signal<br>amplitude) |   | 525  | -    | 625  | mV   |
| V <sub>HSDI</sub>   | high-speed differential input sensitivity   | $ V_{DP} - V_{DM} $   | 300  | -    | -    | mV   |
| V <sub>HSCM</sub>   | high-speed data signaling common-mode voltage range                                     | includes V <sub>DI</sub> range  | -50  | -    | +500 | mV   |
| V <sub>HSOI</sub>   | high-speed idle level   |   | -10  | -    | +10  | mV   |
| V <sub>HSOL</sub>   | high-speed data signaling low   |   | -10  | -    | +10  | mV   |
| Output leve         | ıls   |   |      |      |      |      |
| V <sub>HSOH</sub>   | high-speed data signaling high  |   | 360  | -    | 440  | mV   |
| V <sub>CHIRPJ</sub> | Chirp J level (differential voltage)  |   | 700  | -    | 1100 | mV   |
| V <sub>CHIRPK</sub> | Chirp K level (differential voltage)  |   | -900 | -    | -500 | mV   |
| Leakage c           | urrent  |   |      |      |      |      |
| I <sub>LZ</sub>     | off-state leakage current   |   | -1   | -    | +1   | μΑ   |
| Capacitan           | ce  |   |      |      |      |      |
| C <sub>in</sub>     | input capacitance   | pin to GND  | -    | -    | 5    | pF   |

#### Table 47. Static characteristics: analog I/O pins (DP, DM) ...continued

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

|                         | , 55("5)                          | ******             | •        |     |       |           |
|-------------------------|-----------------------------------|--------------------|----------|-----|-------|-----------|
| Symbol                  | Parameter                         | Conditions         | Min      | Тур | Max   | Unit      |
| Resistance              | e                                 |                    |          |     |       |           |
| R <sub>DN(DP)</sub>     | pull-down resistance on pin DP    |                    | 14.25    | 15  | 15.75 | kΩ        |
| $R_{DN(DM)}$            | pull-down resistance on pin DM    |                    | 14.25    | 15  | 15.75 | $k\Omega$ |
| Termination             | on                                |                    |          |     |       |           |
| Z <sub>O(drv)(DP)</sub> | driver output impedance on pin DP | steady-state drive | [1] 40.5 | 45  | 49.5  | Ω         |
| Z <sub>O(drv)(DM)</sub> | driver output impedance on pin DM | steady-state drive | [1] 40.5 | 45  | 49.5  | Ω         |
| Z <sub>INP</sub>        | input impedance                   |                    | 10       | -   | -     | $M\Omega$ |

<sup>[1]</sup> For high-speed USB and full-speed USB.

#### Table 48. Static characteristics: charge pump

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol               | Parameter                               | Conditions  | Min  | Тур | Max  | Unit |
|----------------------|---|---|------|-----|------|------|
| Voltage              |   |   |      |     |      |      |
| V <sub>O(VBUS)</sub> | output voltage on pin V <sub>BUS</sub>  | $I_{O(VBUS)} = 50 \text{ mA};$ $C_{cp(C\_A)-(C\_B)} = 270 \text{ nF}$ | 4.65 | 5.0 | 5.25 | V    |
| $V_{L(VBUS)}$        | leakage voltage on pin $V_{\text{BUS}}$ | charge pump disabled  | -    | -   | 0.2  | V    |
| Current              |   |   |      |     |      |      |
| I <sub>O(VBUS)</sub> | output current on pin V <sub>BUS</sub>  | $C_{cp(C_A)-(C_B)} = 270 \text{ nF}$                                  | 45   | 75  | -    | mA   |
| Efficiency           |   |   |      |     |      |      |
| $\eta_{\sf cp}$      | charge pump efficiency                  | $I_{O(VBUS)} = 50 \text{ mA}$   | 60   | 72  | 78   | %    |

#### Table 49. Static characteristics: V<sub>BUS</sub> comparators

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol                  | Parameter                                 | Conditions                | Min | Тур | Max  | Unit |
|-------------------------|---|---------------------------|-----|-----|------|------|
| $V_{A\_VBUS\_VLD}$      | A-device V <sub>BUS</sub> valid voltage   |                           | 4.4 | 4.5 | 4.65 | V    |
| $V_{B\_SESS\_VLD}$      | B-device session valid voltage            | for A-device and B-device | 0.8 | 1.6 | 2.0  | V    |
| $V_{hys(B\_SESS\_VLD)}$ | B-device session valid hysteresis voltage |                           | 70  | 90  | 110  | mV   |
| $V_{B\_SESS\_END}$      | B-device session end voltage              |                           | 0.2 | 0.5 | 8.0  | V    |

# Table 50. Static characteristics: $V_{\text{BUS}}$ resistors

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| , i                    | 7 60(1/6)  | umb ,   | •   |      |     |      |
|------------------------|--|---|-----|------|-----|------|
| Symbol                 | Parameter  | Conditions  | Min | Тур  | Max | Unit |
| R <sub>UP(VBUS)</sub>  | pull-up resistance on pin V <sub>BUS</sub>               | connect to pin REG3V3<br>when CHRG_VBUS is<br>logic 1 | 281 | 680  | -   | Ω    |
| R <sub>DN(VBUS)</sub>  | pull-down resistance on pin $V_{\text{BUS}}$             | connect to GND when DISCHRG_VBUS is logic 1           | 656 | 1100 | -   | Ω    |
| $R_{I(idle)(VBUS)(A)}$ | idle input resistance on pin $V_{\text{BUS}}$ (A-device) | ID pin LOW and charge pump disabled                   | 40  | 57   | 80  | kΩ   |
| $R_{I(idle)(VBUS)(B)}$ | idle input resistance on pin $V_{\text{BUS}}$ (B-device) | ID pin HIGH or charge pump enabled                    | 170 | 240  | 310 | kΩ   |

#### Table 51. Static characteristics: ID detection circuit

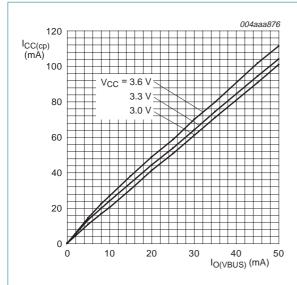
 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol              | Parameter                     | Conditions           | Min | Тур | Max | Unit      |
|---------------------|-------------------------------|----------------------|-----|-----|-----|-----------|
| $t_{ID}$            | ID detection time             |                      | 50  | -   | -   | ms        |
| $V_{th(ID)}$        | ID detector threshold voltage |                      | 8.0 | 1.2 | 2.0 | V         |
| $R_{\text{UP(ID)}}$ | ID pull-up resistance         | ID_PULLUP is logic 1 | 40  | 50  | 60  | $k\Omega$ |

## Table 52. Static characteristics: resistor reference

 $V_{CC}=3.0~V$  to 3.6~V;  $V_{CC(I/O)}=1.65~V$  to 3.6~V;  $T_{amb}=-40~^{\circ}C$  to  $+85~^{\circ}C$ ; unless otherwise specified. Typical values are at  $V_{CC}=3.3~V$ ;  $V_{CC(I/O)}=3.3~V$ ;  $T_{amb}=+25~^{\circ}C$ ; unless otherwise specified.

| Symbol        | Parameter                  | Conditions          | Min | Тур  | Max | Unit |
|---------------|----------------------------|---------------------|-----|------|-----|------|
| $V_{O(RREF)}$ | output voltage on pin RREF | SUSPENDM is logic 1 | -   | 1.22 | -   | V    |



 $I_{\text{CC(cp)}}$  denotes charge pump supply current.

Fig 25. Charge pump supply current vs. V<sub>BUS</sub> output current

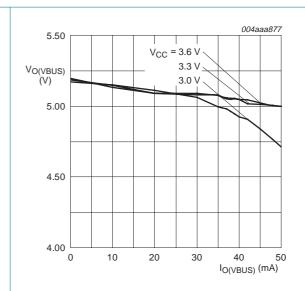
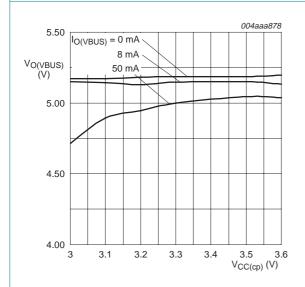
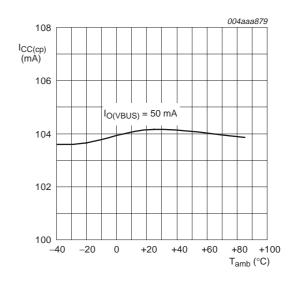


Fig 26. V<sub>BUS</sub> output voltage vs. V<sub>BUS</sub> output current



 $V_{CC(cp)}$  denotes charge pump supply voltage.

Fig 27. V<sub>BUS</sub> output voltage vs. charge pump supply voltage



 $I_{\text{CC(cp)}}$  denotes charge pump supply current.

Fig 28. Charge pump supply current vs. temperature

# 15. Dynamic characteristics

Table 53. Dynamic characteristics: reset and clock

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol                         | Parameter                              | Conditions  | Min          | Тур  | Max  | Unit |
|--------------------------------|--|---|--------------|------|------|------|
| Reset                          |  |   |              |      |      |      |
| $t_{W(POR)}$                   | internal power-on reset pulse width    |   | 0.2          | -    | -    | μs   |
| t <sub>w(REG1V8_H)</sub>       | REG1V8 HIGH pulse width                |   | 2            | -    | -    | μs   |
| t <sub>w(REG1V8_L)</sub>       | REG1V8 LOW pulse width                 |   | 11           | -    | -    | μs   |
| t <sub>W(RESET_N)</sub>        | external RESET_N pulse width           |   | 200          | -    | -    | ns   |
| t <sub>PWRUP</sub>             | regulator start-up time                | 4.7 $\mu$ F $\pm$ 20 % capacitor each on pins REG1V8 and REG3V3 | -            | -    | 1    | ms   |
| Crystal or cloc                | k applied to XTAL1                     |   |              |      |      |      |
| f <sub>i(XTAL1)</sub>          | input frequency on pin XTAL1           | ISP1504ABS  | -            | 19.2 | -    | MHz  |
|                                |  | ISP1504CBS  | -            | 26   | -    | MHz  |
| t <sub>jit(i)(XTAL1)RMS</sub>  | RMS input jitter on pin XTAL1          | ISP1504ABS  | <u>[1]</u> - | -    | 200  | ps   |
|                                |  | ISP1504CBS  | <u>[1]</u> - | -    | 300  | ps   |
| $\Delta f_{i(XTAL1)}$          | input frequency tolerance on pin XTAL1 |   | -            | 50   | 200  | ppm  |
| t <sub>r(XTAL1)</sub>          | rise time on pin XTAL1                 | only for square wave input                                      | -            | -    | 5    | ns   |
| t <sub>f(XTAL1)</sub>          | fall time on pin XTAL1                 | only for square wave input                                      | -            | -    | 5    | ns   |
| V <sub>(XTAL1)(p-p)</sub>      | peak-to-peak voltage on<br>pin XTAL1   | only for square wave input                                      | 0.566        | -    | 1.95 | V    |
| External clock                 | input on CLOCK                         |   |              |      |      |      |
| f <sub>i(CLOCK)</sub>          | input frequency on pin CLOCK           |   | -            | 60   | -    | MHz  |
| t <sub>jit(i)(CLOCK)RMS</sub>  | RMS input jitter on pin CLOCK          |   | [1] -        | -    | 200  | ps   |
| $\Delta f_{i(CLOCK)}$          | input frequency tolerance on pin CLOCK |   | -            | 50   | 200  | ppm  |
| $\delta_{i(\text{CLOCK})}$     | input clock duty cycle on pin CLOCK    |   | 45           | 50   | 55   | %    |
| Output CLOCK                   | Characteristics                        |   |              |      |      |      |
| f <sub>o(CLOCK)</sub>          | output frequency on pin CLOCK          | active only when a<br>crystal or clock is input<br>on pin XTAL1 | -            | 60   | -    | MHz  |
| t <sub>jit(o)(CLOCK)RMS</sub>  | RMS output jitter on pin CLOCK         |   | <u>[1]</u> - | -    | 500  | ps   |
| $\delta_{o(CLOCK)}$            | output clock duty cycle on pin CLOCK   |   | 45           | 50   | 55   | %    |
| t <sub>startup(PLL)</sub>      | PLL startup time                       |   | -            | 650  | -    | μs   |
| t <sub>startup(o)(CLOCK)</sub> | output CLOCK start-up time             | measured from power good or assertion of pin STP                | 450          | 650  | 900  | μs   |

<sup>[1]</sup> RMS = Root Mean Square.

Table 54. Dynamic characteristics: digital I/O pins

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol                | Parameter  | Conditions                        | Min | Тур | Max | Unit |
|-----------------------|--|-----------------------------------|-----|-----|-----|------|
| Output 60             | MHz CLOCK, $V_{CC(I/O)} = 1.65 \text{ V to}$                   | 1.95 V                            |     |     |     |      |
| t <sub>su(DATA)</sub> | DATA set-up time with respect to the rising edge of pin CLOCK  | 20 pF total external load per pin | 5.7 | -   | -   | ns   |
| t <sub>h(DATA)</sub>  | DATA hold time with respect to the rising edge of pin CLOCK    | 20 pF total external load per pin | 0   | -   | -   | ns   |
| t <sub>d(DATA)</sub>  | DATA output delay with respect to the rising edge of pin CLOCK | 20 pF total external load per pin | -   | -   | 7.8 | ns   |
| t <sub>su(STP)</sub>  | STP set-up time with respect to the rising edge of pin CLOCK   | 20 pF total external load per pin | 4.5 | -   | -   | ns   |
| t <sub>h(STP)</sub>   | STP hold time with respect to the rising edge of pin CLOCK     | 20 pF total external load per pin | 0   | -   | -   | ns   |
| t <sub>d(DIR)</sub>   | DIR output delay with respect to the rising edge of pin CLOCK  | 20 pF total external load per pin | -   | -   | 8.9 | ns   |
| t <sub>d(NXT)</sub>   | NXT output delay with respect to the rising edge of pin CLOCK  | 20 pF total external load per pin | -   | -   | 8.9 | ns   |
| Output 60             | MHz CLOCK, V <sub>CC(I/O)</sub> = 3.0 V to                     | 3.6 V                             |     |     |     |      |
| t <sub>su(DATA)</sub> | DATA set-up time with respect to the rising edge of pin CLOCK  | 30 pF total external load per pin | 3.3 | -   | -   | ns   |
| t <sub>h(DATA)</sub>  | DATA hold time with respect to the rising edge of pin CLOCK    | 30 pF total external load per pin | 0.8 | -   | -   | ns   |
| t <sub>d(DATA)</sub>  | DATA output delay with respect to the rising edge of pin CLOCK | 30 pF total external load per pin | -   | -   | 5.5 | ns   |
| t <sub>su(STP)</sub>  | STP set-up time with respect to the rising edge of pin CLOCK   | 30 pF total external load per pin | 3.4 | -   | -   | ns   |
| t <sub>h(STP)</sub>   | STP hold time with respect to the rising edge of pin CLOCK     | 30 pF total external load per pin | 0.8 | -   | -   | ns   |
| t <sub>d(DIR)</sub>   | DIR output delay with respect to the rising edge of pin CLOCK  | 30 pF total external load per pin | -   | -   | 6.6 | ns   |
| t <sub>d(NXT)</sub>   | NXT output delay with respect to the rising edge of pin CLOCK  | 30 pF total external load per pin | -   | -   | 6.6 | ns   |
| Input 60 N            | IHz CLOCK, $V_{CC(I/O)} = 1.65 \text{ V to } 1$                | I.95 V                            |     |     |     |      |
| t <sub>su(DATA)</sub> | DATA set-up time with respect to the rising edge of pin CLOCK  | 10 pF total external load per pin | 4.9 | 4.4 | -   | ns   |
| t <sub>h(DATA)</sub>  | DATA hold time with respect to the rising edge of pin CLOCK    | 10 pF total external load per pin | 0   | -   | -   | ns   |
| t <sub>d(DATA)</sub>  | DATA output delay with respect to the rising edge of pin CLOCK | 10 pF total external load per pin | 9.2 | 5.2 | -   | ns   |
| t <sub>su(STP)</sub>  | STP set-up time with respect to the rising edge of pin CLOCK   | 10 pF total external load per pin | 3.5 | 3.4 | -   | ns   |
| t <sub>h(STP)</sub>   | STP hold time with respect to the rising edge of pin CLOCK     | 10 pF total external load per pin | 0   | -   | -   | ns   |
| t <sub>d(DIR)</sub>   | DIR output delay with respect to the rising edge of pin CLOCK  | 10 pF total external load per pin | -   | 4.9 | 9.3 | ns   |
| t <sub>d(NXT)</sub>   | NXT output delay with respect to                               | 10 pF total external load         | -   | 4.9 | 9.3 | ns   |

 Table 54.
 Dynamic characteristics: digital I/O pins ...continued

 $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

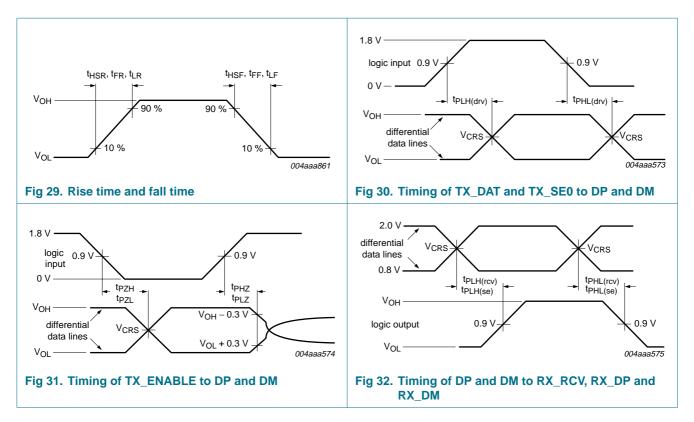
|                       |  | · ·                               |     |     |     |      |
|-----------------------|--|-----------------------------------|-----|-----|-----|------|
| Symbol                | Parameter  | Conditions                        | Min | Тур | Max | Unit |
| Input 60 I            | MHz CLOCK, $V_{CC(I/O)} = 3.0 \text{ V to } 3.0 \text{ V}$     | 6 V                               |     |     |     |      |
| t <sub>su(DATA)</sub> | DATA set-up time with respect to the rising edge of pin CLOCK  | 20 pF total external load per pin | 3.4 | 3.0 | -   | ns   |
| $t_{h(DATA)}$         | DATA hold time with respect to the rising edge of pin CLOCK    | 20 pF total external load per pin | 0   | -   | -   | ns   |
| $t_{d(DATA)}$         | DATA output delay with respect to the rising edge of pin CLOCK | 20 pF total external load per pin | 7.7 | 4.1 | -   | ns   |
| t <sub>su(STP)</sub>  | STP set-up time with respect to the rising edge of pin CLOCK   | 20 pF total external load per pin | 3.1 | 2.7 | -   | ns   |
| $t_{h(STP)}$          | STP hold time with respect to the rising edge of pin CLOCK     | 20 pF total external load per pin | 0   | -   | -   | ns   |
| $t_{d(DIR)}$          | DIR output delay with respect to the rising edge of pin CLOCK  | 20 pF total external load per pin | 7.3 | 3.8 | -   | ns   |
| $t_{d(NXT)}$          | NXT output delay with respect to the rising edge of pin CLOCK  | 20 pF total external load per pin | 7.3 | 3.8 | -   | ns   |
|                       |  |                                   |     |     |     |      |

Table 55. Dynamic characteristics: analog I/O pins (DP and DM)  $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 \,^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol            | Parameter                                | Conditions   | Min | Тур | Max   | Unit |
|-------------------|--|--|-----|-----|-------|------|
| High-spe          | ed driver                                |  |     |     |       |      |
| t <sub>HSR</sub>  | rise time (10 % to 90 %)                 |  | 500 | -   | -     | ps   |
| t <sub>HSF</sub>  | fall time (10 % to 90 %)                 |  | 500 | -   | -     | ps   |
| Full-spee         | ed driver                                |  |     |     |       |      |
| t <sub>FR</sub>   | rise time                                | $C_L = 50 \text{ pF}$ ; 10 % to 90 % of $ V_{OH} - V_{OL} $  | 4   | -   | 20    | ns   |
| t <sub>FF</sub>   | fall time                                | $C_L = 50 \text{ pF}$ ; 10 % to 90 % of $ V_{OH} - V_{OL} $  | 4   | -   | 20    | ns   |
| t <sub>FRFM</sub> | differential rise and fall time matching | excluding the first transition from the idle state   | 90  | -   | 111.1 | %    |
| $V_{CRS}$         | output signal crossover voltage          | excluding the first transition from the idle state   | 1.3 | -   | 2.0   | V    |
| Low-spec          | ed driver                                |  |     |     |       |      |
| t <sub>LR</sub>   | transition time: rise time               | $C_L$ = 200 pF to 600 pF;<br>1.5 k $\Omega$ pull-up on pin DM<br>enabled; 10 % to 90 % of<br>$ V_{OH} - V_{OL} $ | 75  | -   | 300   | ns   |
| t <sub>LF</sub>   | transition time: fall time               | $C_L$ = 200 pF to 600 pF;<br>1.5 k $\Omega$ pull-up on pin DM<br>enabled; 10 % to 90 % of<br>$ V_{OH} - V_{OL} $ | 75  | -   | 300   | ns   |
| t <sub>LRFM</sub> | rise and fall time matching              | $t_{LR}/t_{LF}$ ; excluding the first transition from the idle state   | 80  | -   | 125   | %    |

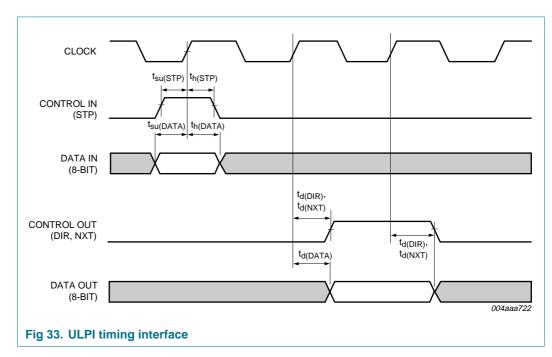
Table 55. Dynamic characteristics: analog I/O pins (DP and DM) ...continued  $V_{CC} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $T_{amb} = -40 ^{\circ}\text{C}$  to  $+85 ^{\circ}\text{C}$ ; unless otherwise specified. Typical values are at  $V_{CC} = 3.3 \text{ V}$ ;  $V_{CC(I/O)} = 3.3 \text{ V}$ ;  $T_{amb} = +25 ^{\circ}\text{C}$ ; unless otherwise specified.

| Symbol                | Parameter                                    | Conditions                                       | Min | Тур | Max | Unit |  |
|-----------------------|--|--|-----|-----|-----|------|--|
| Driver tin            | Driver timing                                |  |     |     |     |      |  |
| t <sub>PLH(drv)</sub> | driver propagation delay (LOW to HIGH)       | TX_DAT, TX_SE0 to DP, DM; see Figure 30          | -   | -   | 11  | ns   |  |
| t <sub>PHL(drv)</sub> | driver propagation delay (HIGH to LOW)       | TX_DAT, TX_SE0 to DP, DM; see Figure 30          | -   | -   | 11  | ns   |  |
| t <sub>PHZ</sub>      | driver disable delay from<br>HIGH level      | TX_ENABLE to DP, DM; see Figure 31               | -   | -   | 12  | ns   |  |
| t <sub>PLZ</sub>      | driver disable delay from<br>LOW level       | TX_ENABLE to DP, DM; see Figure 31               | -   | -   | 12  | ns   |  |
| t <sub>PZH</sub>      | driver enable delay to<br>HIGH level         | TX_ENABLE to DP, DM; see Figure 31               | -   | -   | 20  | ns   |  |
| t <sub>PZL</sub>      | driver enable delay to LOW level             | TX_ENABLE to DP, DM; see Figure 31               | -   | -   | 20  | ns   |  |
| Receiver              | timing                                       |  |     |     |     |      |  |
| Differentia           | al receiver                                  |  |     |     |     |      |  |
| t <sub>PLH(rcv)</sub> | receiver propagation delay (LOW to HIGH)     | DP, DM to RX_RCV, RX_DP and RX_DM; see Figure 32 | -   | -   | 17  | ns   |  |
| t <sub>PHL(rcv)</sub> | receiver propagation delay (HIGH to LOW)     | DP, DM to RX_RCV, RX_DP and RX_DM; see Figure 32 | -   | -   | 17  | ns   |  |
| Single-en             | ded receiver                                 |  |     |     |     |      |  |
| t <sub>PLH(se)</sub>  | single-ended propagation delay (LOW to HIGH) | DP, DM to RX_RCV, RX_DP and RX_DM; see Figure 32 | -   | -   | 17  | ns   |  |
| t <sub>PHL(se)</sub>  | single-ended propagation delay (HIGH to LOW) | DP, DM to RX_RCV, RX_DP and RX_DM; see Figure 32 | -   | -   | 17  | ns   |  |



# 15.1 ULPI timing

ULPI interface timing requirements are given in <u>Figure 33</u>. This timing applies to synchronous mode only. All timing is measured with respect to the ISP1504 CLOCK pin. All signals are clocked on the rising edge of CLOCK.



# 16. Application information

Table 56. Recommended bill of materials

| Designator <sup>[1]</sup> | Application  | Value  | Comment   |
|---------------------------|--|--|---|
| C <sub>bypass</sub>       | highly recommended for all applications  | 0.1 μF   | -   |
| $C_{cp(C\_A)-(C\_B)}$     | charge pump is used  | 22 nF (8 mA), 270 nF (50 mA);<br>up to 470 nF (50 mA)  | -   |
| C <sub>filter</sub>       | highly recommended for all applications  | 4.7 $\mu$ F $\pm$ 20 %; use a LOW ESR capacitor (0.2 $\Omega$ to 2 $\Omega$ ) for best performance | -   |
| C <sub>VBUS</sub>         | mandatory for peripherals  | 0.1 $\mu F$ and 1 $\mu F$ to 10 $\mu F$ in parallel  | -   |
|                           | mandatory for host   | 0.1 $\mu\text{F}$ and 120 $\mu\text{F}\pm20$ % (min) in parallel                                   | -   |
|                           | mandatory for OTG  | 0.1 $\mu F$ and 1 $\mu F$ to 6.5 $\mu F$ in parallel   | -   |
| D <sub>ESD</sub>          | recommended for all ESD-sensitive applications   | IP4059CX5/LF   | Wafer-Level Chip-Scale Package (WLCSP); 1.34 mm $\times$ 0.96 mm $\times$ 0.41 mm; ESD IEC 61000-4-2 level 4; $\pm$ 8 kV contact; $\pm$ 15 kV air discharge |
| R <sub>pullup</sub>       | recommended; for applications with an external V <sub>BUS</sub> supply controlled by PSW_N   | 4.7 kΩ to 100 kΩ (10 kΩ recommended)   | maximum value is determined by the voltage drop on PSW_N caused by leakage into PSW_N and the external supply control pin                                   |
| R <sub>RREF</sub>         | mandatory in all applications  | 12 k $\Omega$ ± 1 %  | -   |
| R <sub>VBUS</sub>         | strongly recommended for<br>peripheral or external 5 V<br>applications only                  | 1 k $\Omega$ ± 5 %   | -   |
| R <sub>XTAL</sub>         | required only for<br>applications driving a<br>square wave into the<br>XTAL1 pin             | $47 \text{ k}\Omega \pm 5 \%$  | used to avoid floating input on the XTAL1 pin   |
| XTAL                      | crystal is used  | 19.2 MHz   | $C_L = 10 \text{ pF}; R_S < 220 \Omega; C_{XTAL} = 18 \text{ pF}$   |
|                           |  | 26 MHz   | $C_L = 10 \text{ pF}; R_S < 130 \Omega; C_{XTAL} = 18 \text{ pF}$   |
| C <sub>(XTAL)SQ</sub>     | required only for applications driving a square wave into the XTAL1 pin that has a DC offset | 100 pF   | used to AC couple the input square wave to the XTAL1 pin  |

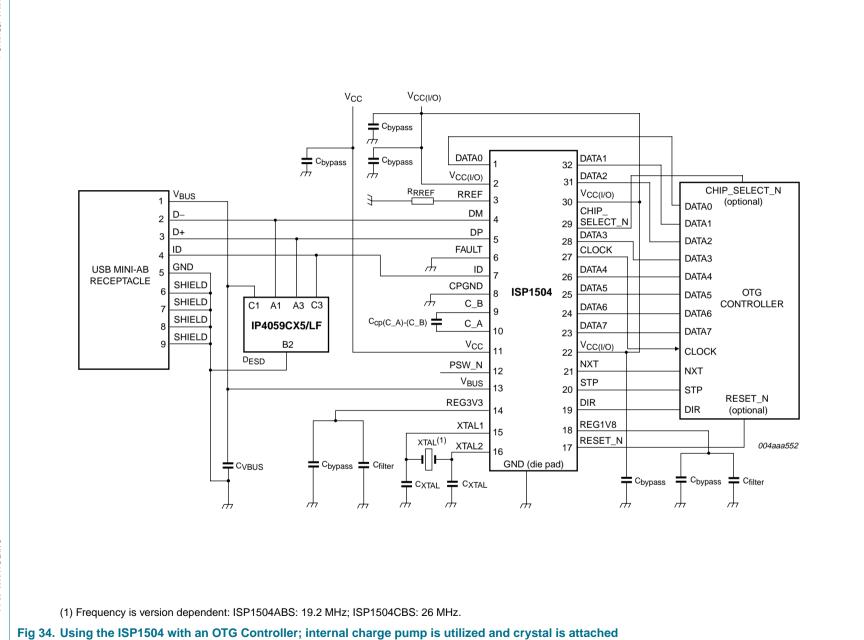
<sup>[1]</sup> For detailed information and alternative interface options, refer to the Interfacing to the ISP1504/5/6 (AN10048) application note.

Product data sheet

Rev. 01 19 October 2006

© NXP B.V. 2006. All rights





**‡** C<sub>bypass</sub>

C<sub>bypass</sub>

004aaa553

Product data sheet  $V_{CC}$  $V_{CC(I/O)}$ Cbypass 3.3 V IN FAULT DATA1 C<sub>bypass</sub> DATA0 32 Cbypass CHARGE DATA2 V<sub>CC(I/O)</sub> R<sub>pullup</sub> 31 PUMP 5 V CHIP\_SELECT\_N RRREF V<sub>CC(I/O)</sub> **RREF** ON 30 OUT (optional) CHIP DATA0 DM SELECT\_N 29 DATA1 DATA3 DP 28 DATA2 Rev. 01 CLOCK V<sub>BUS</sub> **FAULT** 27 DATA3 D-ID DATA4 DATA4 D+ **CPGND** DATA5 OTG DATA5 CONTROLLER ISP1504 25 19 ID C\_B DATA6 24 DATA6 October 2006 **USB MINI-AB** GND C\_A DATA7 RECEPTACLE 5 DATA7 23 SHIELD  $V_{CC}$ V<sub>CC(I/O)</sub> CLOCK 22 SHIELD C1 A1 A3 C3 PSW\_N NXT 21 NXT SHIELD RVBUS VBUS IP4059CX5/LF STP 20 SHIELD B2 RESET\_N DIR REG3V3 19 (optional) DESD REG1V8 XTAL1 18 RESET\_N XTAL2 17 GND (die pad)

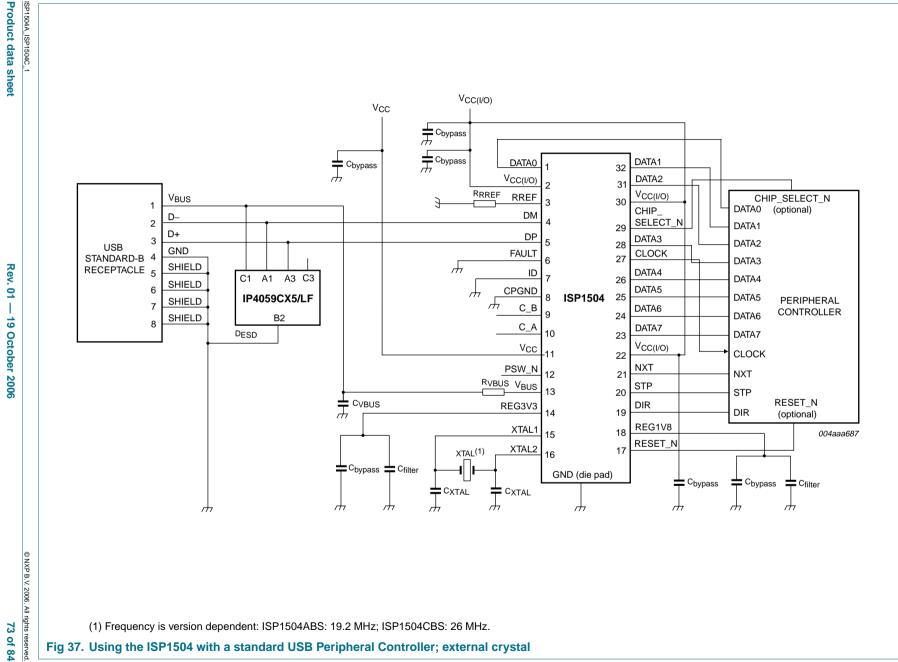
**CVBUS** 

Fig 35. Using the ISP1504 with an OTG Controller; external charge pump using the ISP1504 internal V<sub>BUS</sub> valid and external 60 MHz input on CLOCK

(1) Frequency is version dependent: ISP1504ABS: 19.2 MHz; ISP1504CBS: 26 MHz.

Fig 36. Using the ISP1504 with a standard USB Host Controller; external 5 V source with built-in FAULT and external square wave input on XTAL1

© NXP B.V. 2006. All rights reserved. **72 of 84** 



# 17. Package outline

HVQFN32: plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body  $5 \times 5 \times 0.85 \text{ mm}$ 

SOT617-1

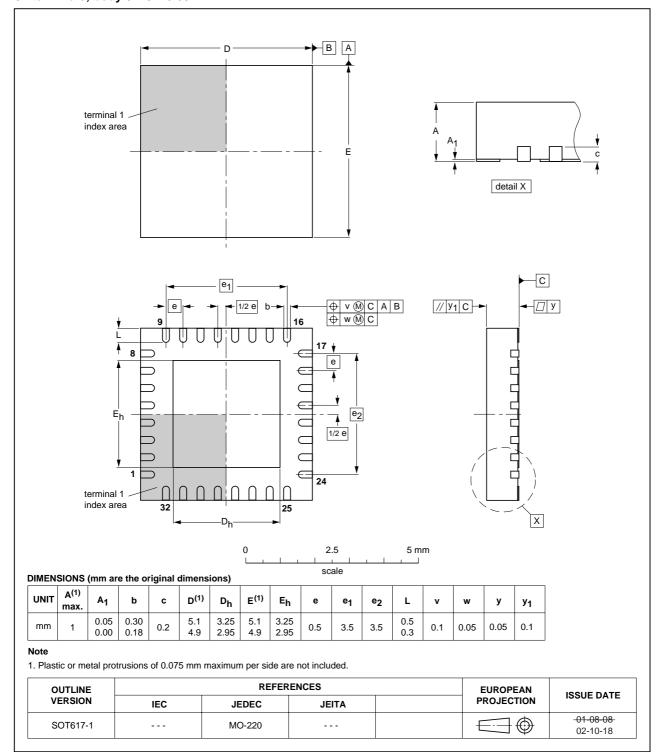


Fig 38. Package outline SOT617-1 (HVQFN32)

ISP1504A\_ISP1504C\_1 © NXP B.V. 2006. All rights reserved.

# 18. Soldering

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

### 18.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 18.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- · Lead-free soldering versus PbSn soldering

### 18.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

# 18.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 39</u>) than a PbSn process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 57 and 58

Table 57. SnPb eutectic process (from J-STD-020C)

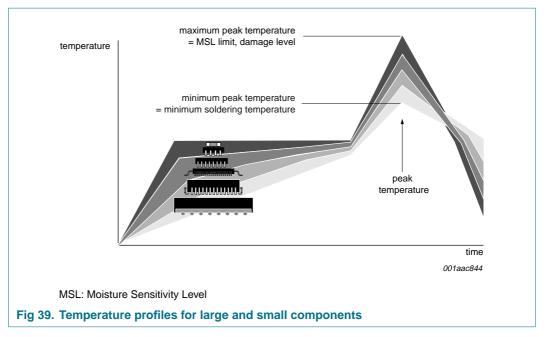
| Package thickness (mm) | Package reflow temperature (°C) Volume (mm³) |       |  |
|------------------------|--|-------|--|
|                        |  |       |  |
|                        | < 350  | ≥ 350 |  |
| < 2.5                  | 235  | 220   |  |
| ≥ 2.5                  | 220  | 220   |  |

Table 58. Lead-free process (from J-STD-020C)

| Package thickness (mm) | Package reflow temperature (°C) |             |        |  |
|------------------------|---------------------------------|-------------|--------|--|
|                        | Volume (mm <sup>3</sup> )       |             |        |  |
|                        | < 350                           | 350 to 2000 | > 2000 |  |
| < 1.6                  | 260                             | 260         | 260    |  |
| 1.6 to 2.5             | 260                             | 250         | 245    |  |
| > 2.5                  | 250                             | 245         | 245    |  |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 39.



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

# 19. Abbreviations

Table 59. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| ATX     | Analog USB Transceiver      |
| EOP     | End-Of-Packet               |
| ESD     | ElectroStatic Discharge     |
| FS      | Full-Speed                  |
| HBM     | Human Body Model            |
| HNP     | Host Negotiation Protocol   |
| HS      | High-Speed                  |
| ID      | Identification              |
| LS      | Low-Speed                   |
| NRZI    | Non-Return-to-Zero Inverted |
| OTG     | On-The-Go                   |
| PHY     | Physical Layer[1]           |
| PID     | Packet Identifier           |
| POR     | Power-On Reset              |
| RXCMD   | Receive Command             |
| SE0     | Single-Ended Zero           |
| SOF     | Start-Of-Frame              |
| SRP     | Session Request Protocol    |
| SYNC    | Synchronous                 |

Table 59. Abbreviations ... continued

| Acronym | Description                                  |
|---------|--|
| TTL     | Transistor-Transistor Logic                  |
| TXCMD   | Transmit Command                             |
| USB     | Universal Serial Bus                         |
| USB-IF  | USB Implementers Forum                       |
| ULPI    | UTMI+ Low Pin Interface                      |
| UTMI    | USB 2.0 Transceiver Macrocell Interface      |
| UTMI+   | USB 2.0 Transceiver Macrocell Interface Plus |

<sup>[1]</sup> Physical layer containing the USB transceiver. The ISP1504 is a PHY.

## 20. References

- [1] Universal Serial Bus Specification Rev. 2.0
- [2] On-The-Go Supplement to the USB 2.0 Specification Rev. 1.2
- [3] UTMI+ Low Pin Interface (ULPI) Specification Rev. 1.1
- [4] UTMI+ Specification Rev. 1.0
- [5] USB 2.0 Transceiver Macrocell Interface (UTMI) Specification Ver. 1.05
- [6] Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM) (JESD22-A114D)
- [7] Interfacing to the ISP1504/5/6 (AN10048)

# 21. Revision history

#### Table 60. Revision history

| Document ID         | Release date | Data sheet status  | Change notice | Supersedes |
|---------------------|--------------|--------------------|---------------|------------|
| ISP1504A_ISP1504C_1 | 20061019     | Product data sheet | -             | -          |

# 22. Legal information

#### 22.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 22.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

### 22.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfunction of a NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

#### 22.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

### 23. Contact information

For additional information, please visit: <a href="http://www.nxp.com">http://www.nxp.com</a>

For sales office addresses, send an email to: <a href="mailto:salesaddresses@nxp.com">salesaddresses@nxp.com</a>

ISP1504A\_ISP1504C\_1 © NXP B.V. 2006. All rights reserved.

# 24. Tables

| Table 1.              | Ordering information   | Table 29. | USB Interrupt Enable Rising Edge register                   |
|-----------------------|--|-----------|---|
| Table 2.              | Pin description  |           | (address $R = 0Dh$ to $0Fh$ , $W = 0Dh$ , $S = 0Eh$ , $C =$ |
| Table 3.              | Recommended charge pump capacitor value .12  |           | 0Fh) bit description52                                      |
| Table 4.              | ULPI signal description15  | Table 30. | USB Interrupt Enable Falling Edge register                  |
| Table 5.              | Signal mapping during low-power mode 16  |           | (address R = 10h to 12h, W = 10h, S = 11h, C =              |
| Table 6.              | Signal mapping for 6-pin serial mode17   |           | 12h) bit allocation52                                       |
| Table 7.              | Signal mapping for 3-pin serial mode18   | Table 31. | USB Interrupt Enable Falling Edge register                  |
| Table 8.              | Operating states and their corresponding resistor  |           | (address R = 10h to 12h, W = 10h, S = 11h, C =              |
|                       | settings18   |           | 12h) bit description  |
| Table 9.              | OTG Control register power control bits25  | Table 32. | USB Interrupt Status register (address R = 13h)             |
| Table 10.             | TXCMD byte format  |           | bit allocation53  |
|                       | RXCMD byte format  | Table 33. | USB Interrupt Status register (address R = 13h)             |
|                       | LINESTATE[1:0] encoding for upstream facing  |           | bit description53   |
|                       | ports: peripheral  | Table 34. | USB Interrupt Latch register (address R = 14h) bit          |
| Table 13.             | LINESTATE[1:0] encoding for downstream facing  |           | allocation  |
|                       | ports: host  | Table 35. | USB Interrupt Latch register (address R = 14h) bit          |
| Table 14.             | V <sub>BUS</sub> indicators in RXCMD required for typical                                  |           | description   |
|                       | applications29   | Table 36. | Debug register (address $R = 15h$ ) bit allocation .        |
| Table 15.             | PHY pipeline delays  |           | 54  |
|                       | Link decision times35  | Table 37. | Debug register (address R = 15h) bit                        |
|                       | Register map overview47  |           | description   |
|                       | Vendor ID Low register (address R = 00h) bit   | Table 38. | Scratch register (address R = 16h to 18h, W =               |
|                       | description  |           | 16h, S = 17h, C = 18h) bit description 54                   |
| Table 19.             | Vendor ID High register (address R = 01h) bit  | Table 39. | Power Control register (address R = 3Dh to 3Fh,             |
|                       | description  |           | W = 3Dh, $S = 3Eh$ , $C = 3Fh$ ) bit allocation54           |
| Table 20.             | Product ID Low register (address R = 02h) bit  | Table 40. | Power Control register (address R = 3Dh to 3Fh,             |
|                       | description  |           | W = 3Dh, $S = 3Eh$ , $C = 3Fh$ ) bit description 55         |
| Table 21.             | Product ID High register (address R = 03h) bit   | Table 41. | Limiting values   |
|                       | description  |           | Recommended operating conditions 57                         |
| Table 22.             | Function Control register (address R =   |           | Static characteristics: supply pins                         |
|                       | 04h to 06h, W = 04h, S = 05h, C = 06h) bit   |           | Static characteristics: digital pins (CLOCK, DIR,           |
|                       | allocation   |           | STP, NXT, DATA[7:0], RESET_N,                               |
| Table 23              | Function Control register (address R   |           | CHIP_SELECT_N)  |
| 10010 20.             | = 04h to 06h, W = 04h, S = 05h, C = 06h) bit   | Table 45  | Static characteristics: digital pin FAULT 59                |
|                       | description  |           | Static characteristics: digital pin PSW_N59                 |
| Table 24              | Interface Control register (address R =  |           | Static characteristics: analog I/O pins                     |
| 10010 2 1.            | 07h  to  09h, W = 07h, S = 08h, C = 09h)  bit  | 14510 17. | (DP, DM)  |
|                       | allocation49   | Table 48  | Static characteristics: charge pump61                       |
| Table 25              | Interface Control register (address R =  |           | Static characteristics: V <sub>BUS</sub> comparators61      |
| Table 20.             | 07h to 09h, W = 07h, S = 08h, C = 09h) bit   |           | Static characteristics: V <sub>BUS</sub> resistors          |
|                       | description  |           | Static characteristics: ID detection circuit62              |
| Table 26              | OTG Control register (address R = 0Ah to 0Ch,  |           | Static characteristics: resistor reference 62               |
| Table 20.             | W = 0Ah, $S = 0Bh$ , $C = 0Ch$ ) bit allocation50  |           | Dynamic characteristics: reset and clock 64                 |
| Table 27              |  |           | Dynamic characteristics: digital I/O pins 65                |
| iable 21.             | OTG Control register (address R = 0Ah to 0Ch, W = 0Ah, S = 0Bh, C = 0Ch) bit description51 |           | Dynamic characteristics: analog I/O pins (DP and            |
| Table 29              | USB Interrupt Enable Rising Edge register  | เลมเช ออ. | DM)   |
| 1001 <del>0</del> 20. | (address R = 0Dh to 0Fh, W = 0Dh, S = 0Eh, C =   | Table 56  | Recommended bill of materials                               |
|                       |  |           |   |
|                       | 0Fh) bit allocation51  | iable 5/. | SnPb eutectic process (from J-STD-020C) 76                  |

continued >>

## **NXP Semiconductors**

# ISP1504A; ISP1504C

# **ULPI HS USB OTG transceiver**

| Table 58. | Lead-free process (from J-STD-020C) | 76 |
|-----------|-------------------------------------|----|
| Table 59. | Abbreviations                       | 77 |
| Table 60. | Revision history                    | 78 |

continued >>

 ISP1504A\_ISP1504C\_1
 © NXP B.V. 2006. All rights reserved.

# 25. Figures

| Fig 1.             | Block diagram4  |
|--------------------|---|
| Fig 2.             | Pin configuration HVQFN32; top view 5                                 |
| Fig 3.             | External capacitors connection  |
| Fig 4.             | Charge pump capacitor   |
| Fig 5.             | Internal power-on reset timing  |
| Fig 6.             | Power-up and reset sequence required before the                       |
| 3 -                | ULPI bus is ready for use22   |
| Fig 7.             | Interface behavior with respect to RESET_N 23                         |
| Fig 8.             | Entering and exiting 3-state in normal mode 24                        |
| Fig 9.             | Entering and exiting 3-state in suspend mode25                        |
| Fig 10.            | Single and back-to-back RXCMDs from the ISP1504 to the link27         |
| Eia 11             | RXCMD A_VBUS_VLD indicator source                                     |
| Fig 11.<br>Fig 12. |   |
| rig iz.            | Example of register write, register read, extended                    |
| Eig 12             | register write and extended register read31                           |
| Fig 13.            | USB reset and high-speed detection handshake                          |
| Tio 11             | (chirp) sequence  |
| Fig 14.            | Example of using the ISP1504 to transmit and receive USB data34       |
| Eia 15             |   |
| Fig 15.            | High-speed transmit-to-transmit packet timing35                       |
| Fig 16.            | High-speed receive-to-transmit packet timing 36                       |
| Fig 17.            | Preamble sequence   |
| Fig 18.            | Full-speed suspend and resume   |
| Fig 19.            | High-speed suspend and resume   |
| Fig 20.            | Remote wake-up from low-power mode                                    |
| Fig 21.            | Transmitting USB packets without automatic SYNC and EOP generation    |
| Fig 22.            | Example of transmit followed by receive in 6-pin                      |
|                    | serial mode   |
| Fig 23.            | Example of transmit followed by receive in 3-pin                      |
|                    | serial mode   |
| Fig 24.            | Human body ESD test model   |
| Fig 25.            | Charge pump supply current vs. V <sub>BUS</sub> output                |
|                    | current   |
| Fig 26.            | V <sub>BUS</sub> output voltage vs. V <sub>BUS</sub> output current63 |
| Fig 27.            | V <sub>BUS</sub> output voltage vs. charge pump supply voltage        |
| Fig 28.            | Charge pump supply current vs. temperature63                          |
| Fig 29.            | Rise time and fall time   |
| Fig 30.            | Timing of TX_DAT and TX_SE0 to DP and DM68                            |
| Fig 31.            | Timing of TX_ENABLE to DP and DM68                                    |
| Fig 32.            | Timing of DP and DM to RX_RCV, RX_DP and                              |
| 9 0=.              | RX_DM   |
| Fig 33.            | ULPI timing interface   |
| Fig 34.            | Using the ISP1504 with an OTG Controller; internal                    |
| 9 0 1.             | charge pump is utilized and crystal is attached70                     |
| Fig 35.            | Using the ISP1504 with an OTG Controller; external                    |
|                    | charge pump using the ISP1504 internal V <sub>BUS</sub> valid         |

|         | and external 60 MHz input on CLOCK 71               |
|---------|---|
| Fig 36. | Using the ISP1504 with a standard USB Host          |
|         | Controller; external 5 V source with built-in FAULT |
|         | and external square wave input on XTAL1 72          |
| Fig 37. | Using the ISP1504 with a standard USB Peripheral    |
|         | Controller; external crystal73                      |
| Fig 38. | Package outline SOT617-1 (HVQFN32) 74               |
| Fig 39. | Temperature profiles for large and small            |
|         | components77  |
|         |   |

continued >>

# 26. Contents

| 1       | General description                  | . 1 | 8.1     | ULPI modes  | _ |
|---------|--------------------------------------|-----|---------|---|---|
| 2       | Features                             | . 1 | 8.1.1   | Synchronous mode                                  | 5 |
| 3       | Applications                         |     | 8.1.2   | Low-power mode                                    |   |
| 4       | Ordering information                 |     | 8.1.3   | 6-pin full-speed or low-speed serial mode 1       | 7 |
| -       | _                                    |     | 8.1.4   | 3-pin full-speed or low-speed serial mode 1       |   |
| 5       | Block diagram                        |     | 8.2     | USB and OTG state transitions                     | 8 |
| 6       | Pinning information                  |     | 9       | Protocol description                              | 0 |
| 6.1     | Pinning                              |     | 9.1     | ULPI references                                   | 0 |
| 6.2     | Pin description                      | . 5 | 9.2     | Power-On Reset (POR)                              | 0 |
| 7       | Functional description               | . 7 | 9.3     | Power-up, reset and bus idle sequence 2           | 0 |
| 7.1     | ULPI interface controller            | . 7 | 9.3.1   | Interface protection                              | 3 |
| 7.2     | USB data serializer and deserializer | . 7 | 9.3.2   | Interface behavior with respect to RESET_N. 2     | 3 |
| 7.3     | Hi-Speed USB (USB 2.0) ATX           | . 7 | 9.3.3   | Interface behavior with respect to                |   |
| 7.4     | Voltage regulator                    |     |         | CHIP_SELECT_N                                     | 3 |
| 7.5     | Crystal oscillator and PLL           | . 8 | 9.4     | V <sub>BUS</sub> power and fault detection 25     | 5 |
| 7.6     | OTG module                           | . 8 | 9.4.1   | Driving 5 V on V <sub>BUS</sub>                   | 5 |
| 7.6.1   | ID detector                          | . 9 | 9.4.2   | Fault detection 25                                | 5 |
| 7.6.2   | V <sub>BUS</sub> comparators         |     | 9.5     | TXCMD and RXCMD 20                                | 6 |
| 7.6.2.1 | V <sub>BUS</sub> valid comparator    | . 9 | 9.5.1   | TXCMD 20  | 6 |
| 7.6.2.2 | Session valid comparator             |     | 9.5.2   | RXCMD   | 6 |
| 7.6.2.3 | Session end comparator               |     | 9.5.2.1 | Linestate encoding                                | 7 |
| 7.6.3   | SRP charge and discharge resistors   | . 9 | 9.5.2.2 | V <sub>BUS</sub> state encoding                   | 8 |
| 7.6.4   | Charge pump                          | 10  | 9.5.2.3 | RxEvent encoding 3                                | 0 |
| 7.7     | Band gap reference voltage           | 10  | 9.6     | Register read and write operations 30             | 0 |
| 7.8     | Power-On Reset (POR)                 | 10  | 9.7     | USB reset and high-speed detection handshake      |   |
| 7.9     | Detailed description of pins         | 10  |         | (chirp)   | 1 |
| 7.9.1   | DATA[7:0]                            | 10  | 9.8     | USB packet transmit and receive 3                 | 4 |
| 7.9.2   | V <sub>CC(I/O)</sub>                 |     | 9.8.1   | USB packet timing                                 | 4 |
| 7.9.3   | RREF                                 | 11  | 9.8.1.1 | ISP1504 pipeline delays                           |   |
| 7.9.4   | DP and DM                            |     | 9.8.1.2 | Allowed link decision time                        |   |
| 7.9.5   | FAULT                                |     | 9.9     | Preamble  |   |
| 7.9.6   | ID                                   | 11  | 9.10    | USB suspend and resume 3                          | 7 |
| 7.9.7   | CPGND                                |     | 9.10.1  | Full-speed or low-speed host-initiated suspend    |   |
| 7.9.8   | C_A and C_B                          |     |         | and resume 3                                      |   |
| 7.9.9   | V <sub>CC</sub>                      |     | 9.10.2  | High-speed suspend and resume 3                   |   |
| 7.9.10  | PSW_N                                |     | 9.10.3  | Remote wake-up 4                                  | 1 |
| 7.9.11  | V <sub>BUS</sub>                     |     | 9.11    | No automatic SYNC and EOP generation              |   |
| 7.9.12  | REG3V3 and REG1V8                    |     |         | (optional)  |   |
| 7.9.13  | XTAL1 and XTAL2                      |     | 9.12    | On-The-Go operations 4                            |   |
| 7.9.14  | RESET_N                              |     | 9.12.1  | OTG charge pump 4                                 |   |
| 7.9.15  | DIR                                  | 13  | 9.12.2  | OTG comparators 4-                                |   |
| 7.9.16  | STP                                  |     | 9.12.3  | Pull-up and pull-down resistors 4                 |   |
| 7.9.17  | NXT                                  |     | 9.12.4  | ID detection 4                                    |   |
| 7.9.18  | CLOCK                                |     | 9.12.5  | V <sub>BUS</sub> charge and discharge resistors 4 |   |
| 7.9.19  | CHIP_SELECT_N                        |     | 9.13    | Serial modes 4                                    |   |
| 7.9.20  | GND (die pad)                        | 14  | 9.14    | Aborting transfers 4                              |   |
| 8       | Modes of operation                   | 15  | 9.15    | Avoiding contention on the ULPI data bus 4        | 6 |
|         |                                      |     | 10      | Register map 4                                    | 7 |

continued >>

# ISP1504A; ISP1504C

### **NXP Semiconductors**

### **ULPI HS USB OTG transceiver**

| 10.1               | Immediate register set                       |      |
|--------------------|--|------|
| 10.1.1             | Vendor ID and Product ID registers           |      |
| 10.1.1.1           | 3 1 1  |      |
| 10.1.1.2           | 3 - 3  |      |
| 10.1.1.3           |  |      |
| 10.1.1.4           | 3 - 3  |      |
| 10.1.2             | Function Control register                    |      |
| 10.1.3             | Interface Control register                   |      |
| 10.1.4             | OTG Control register                         |      |
| 10.1.5             | USB Interrupt Enable Rising Edge register .  |      |
| 10.1.6             | USB Interrupt Enable Falling Edge register . |      |
| 10.1.7             | USB Interrupt Status register                |      |
| 10.1.8             | USB Interrupt Latch register                 |      |
| 10.1.9             | Debug register                               |      |
| 10.1.10            | Scratch register                             |      |
| 10.1.11            | Reserved                                     |      |
| 10.1.12            | Access extended register set                 |      |
| 10.1.13<br>10.1.14 | Vendor-specific registers                    |      |
| 10.1.14            | Power Control register                       |      |
| -                  | Extended register set                        |      |
| 11                 | ElectroStatic Discharge (ESD)                |      |
| 11.1               | ESD protection                               |      |
| 11.2               | ESD test conditions                          |      |
| 12                 | Limiting values                              |      |
| 13                 | Recommended operating conditions             |      |
| 14                 | Static characteristics                       | . 58 |
| 15                 | Dynamic characteristics                      | . 64 |
| 15.1               | ULPI timing                                  | . 68 |
| 16                 | Application information                      | . 69 |
| 17                 | Package outline                              | . 74 |
| 18                 | Soldering                                    | . 75 |
| 18.1               | Introduction to soldering                    |      |
| 18.2               | Wave and reflow soldering                    |      |
| 18.3               | Wave soldering                               |      |
| 18.4               | Reflow soldering                             |      |
| 19                 | Abbreviations                                |      |
| 20                 | References                                   |      |
| 21                 | Revision history                             |      |
| <br>22             | Legal information                            |      |
| 22.1               | Data sheet status                            |      |
| 22.1               | Definitions                                  |      |
| 22.3               | Disclaimers                                  |      |
| 22.4               | Trademarks                                   |      |
| 23                 | Contact information                          |      |
| 23<br>24           | Tables                                       |      |
|                    | Figures                                      |      |
| 25                 | •  |      |
| 26                 | Contents                                     | . 83 |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

